

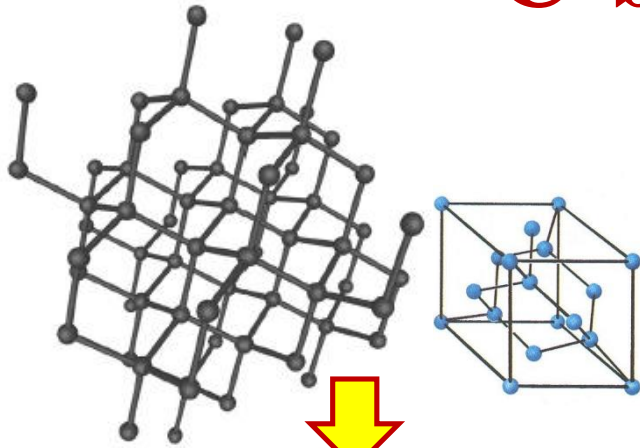
Diamond-like Carbon (DLC)

films deposited by

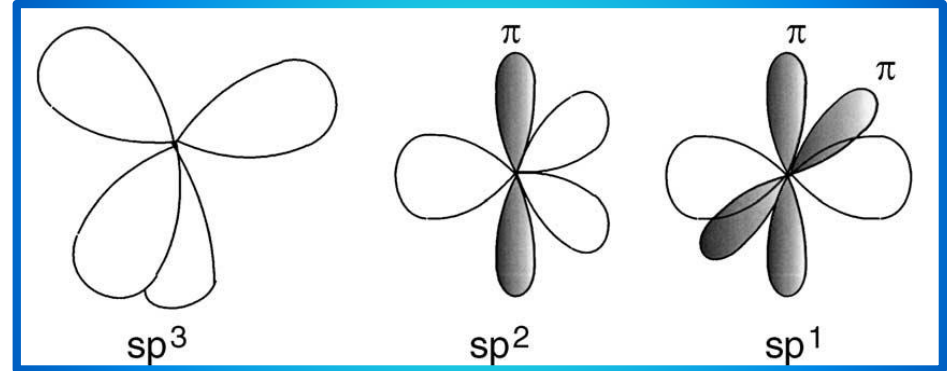
Pulsed Laser Deposition (PLD)



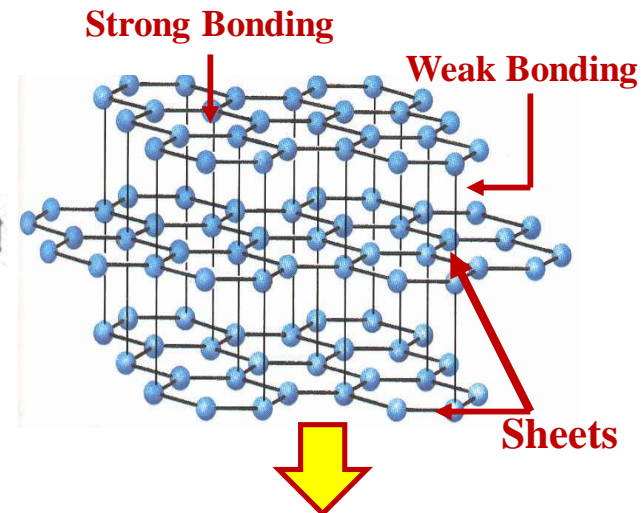
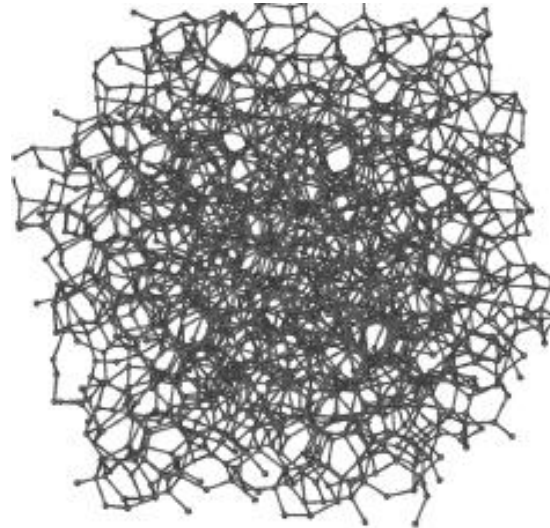
C-based materials



**Diamond: 100 % sp^3
bonded carbon**

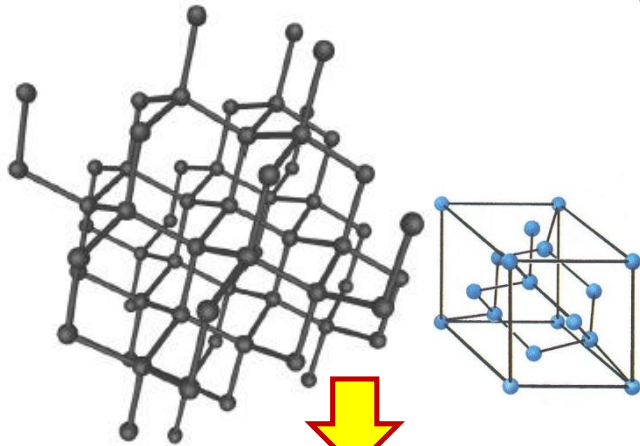


Amorphous C: $sp^3 + sp^2$

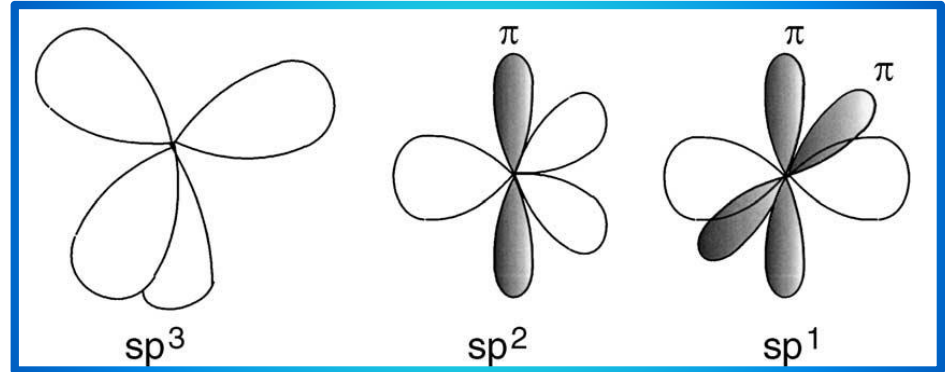


**Graphite: 100 % sp^2
bonded carbon**

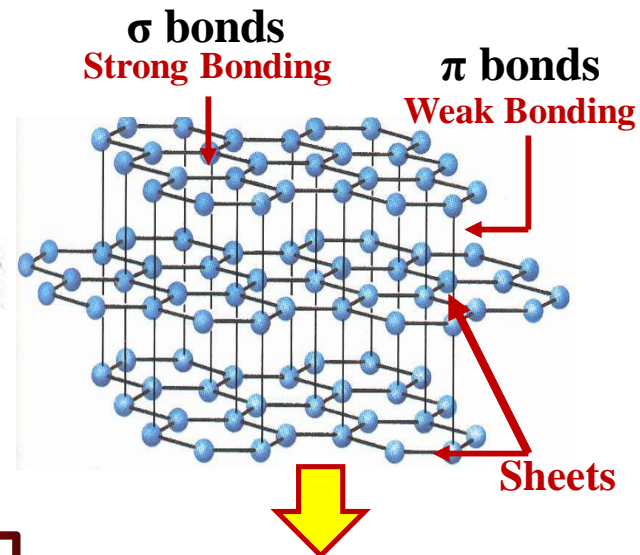
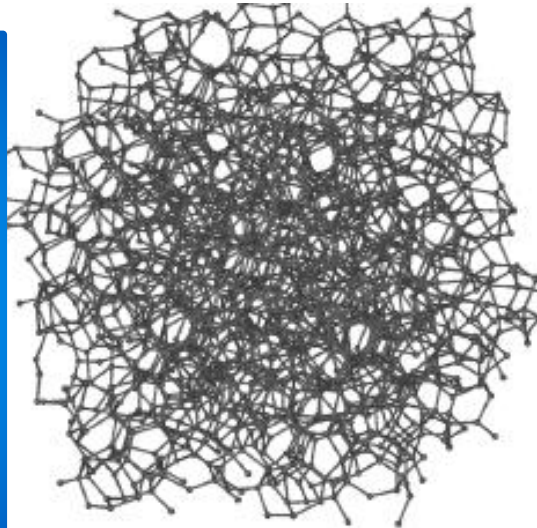
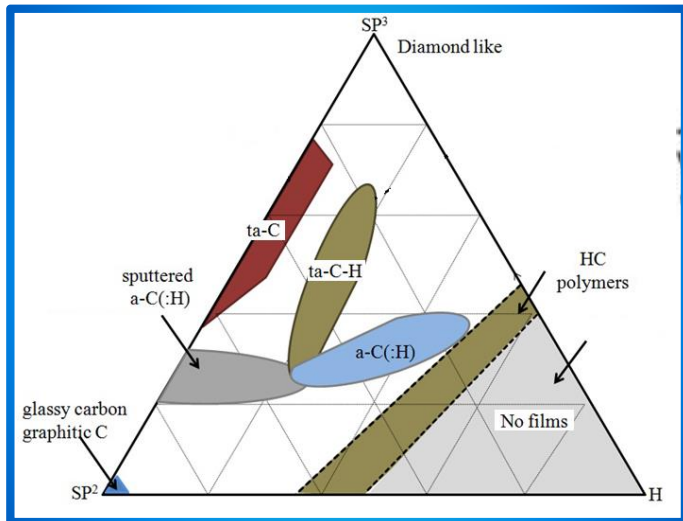
DLC: general properties



Diamond: 100 % sp^3 bonded carbon



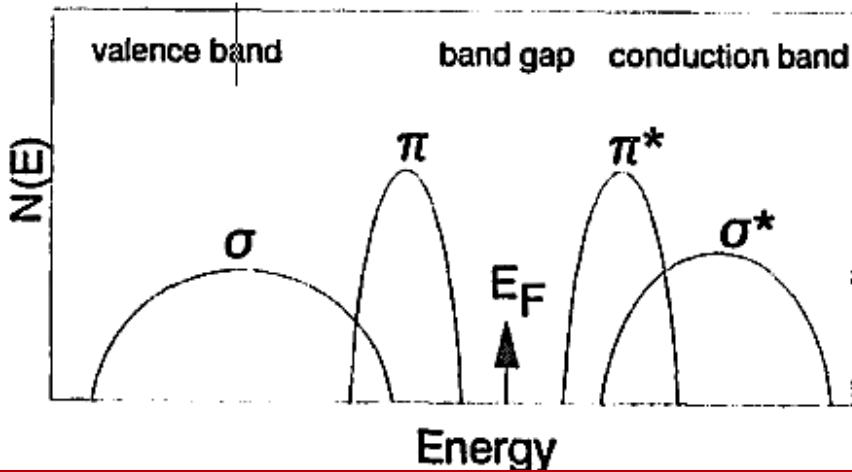
Amorphous C: $sp^3 + sp^2$



Graphite: 100 % sp^2 bonded carbon

DLC: metastable C-phase containing a mixture of sp^3 (> 60%) and sp^2 C-C bonds

C-based materials: band structure



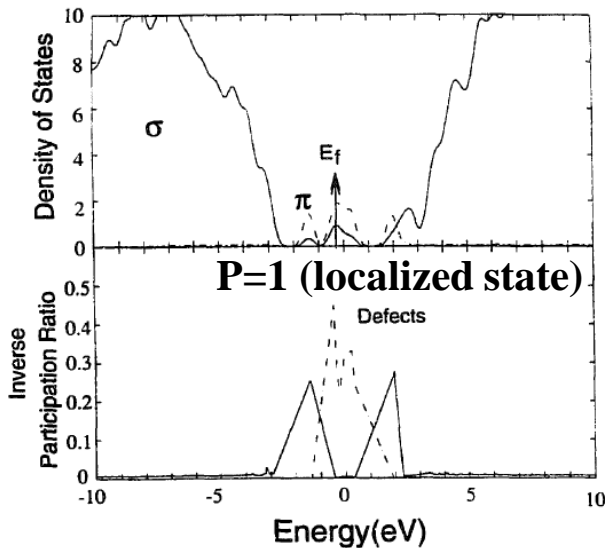
$sp^3 \rightarrow$ tetrahedral σ bonds
 $sp^2 \rightarrow$ trigonal σ bonds and weak π bonds

$\sigma, \sigma^* \rightarrow$ deep valence and conduction (extended) states

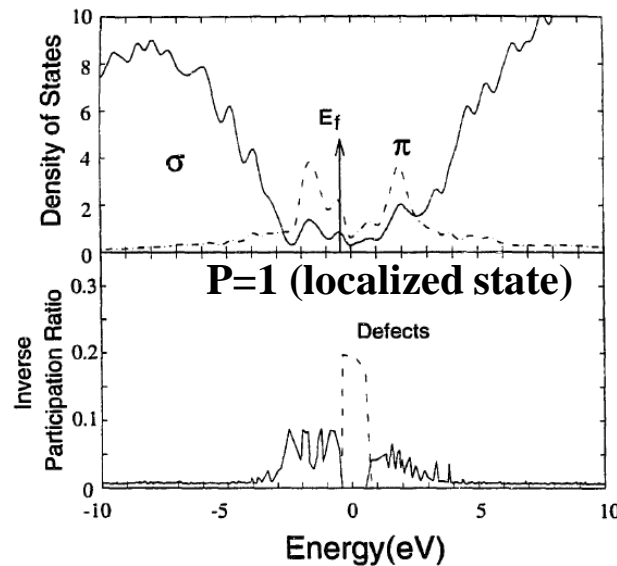
$\pi, \pi^* \rightarrow$ band edge valence and conduction (localized) states

Band gap is formed by π and π^* states

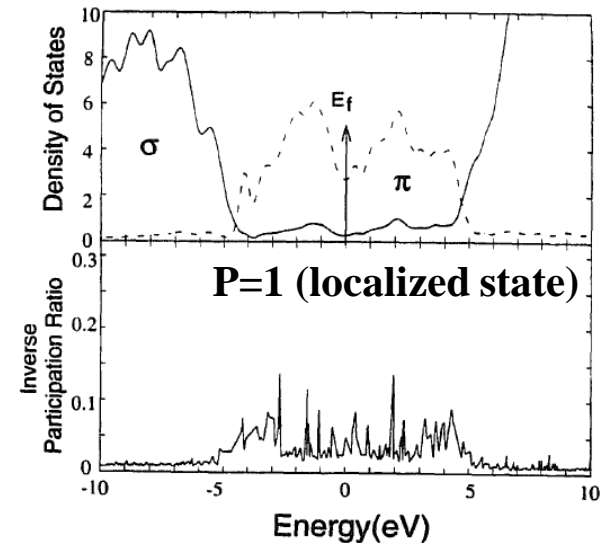
92 % sp^3 bonding



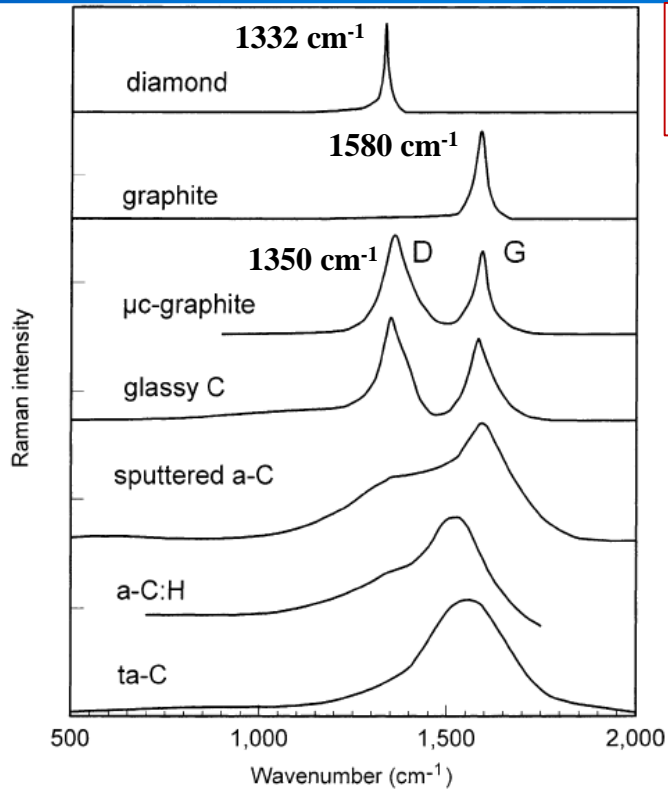
69 % sp^3 bonding



20 % sp^3 bonding

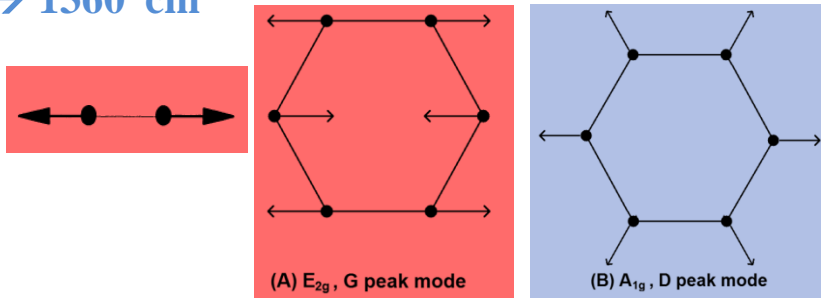


DLC: Raman spectroscopy



Under visible laser excitation:

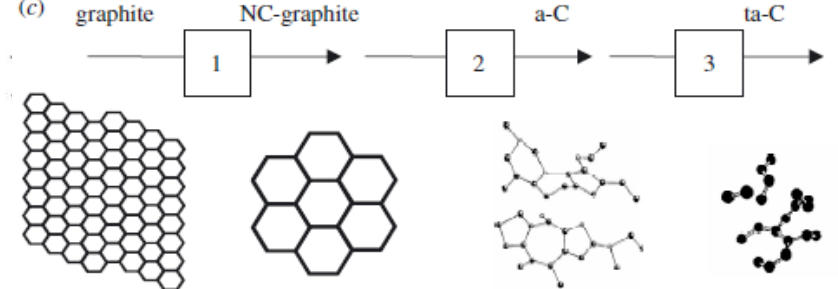
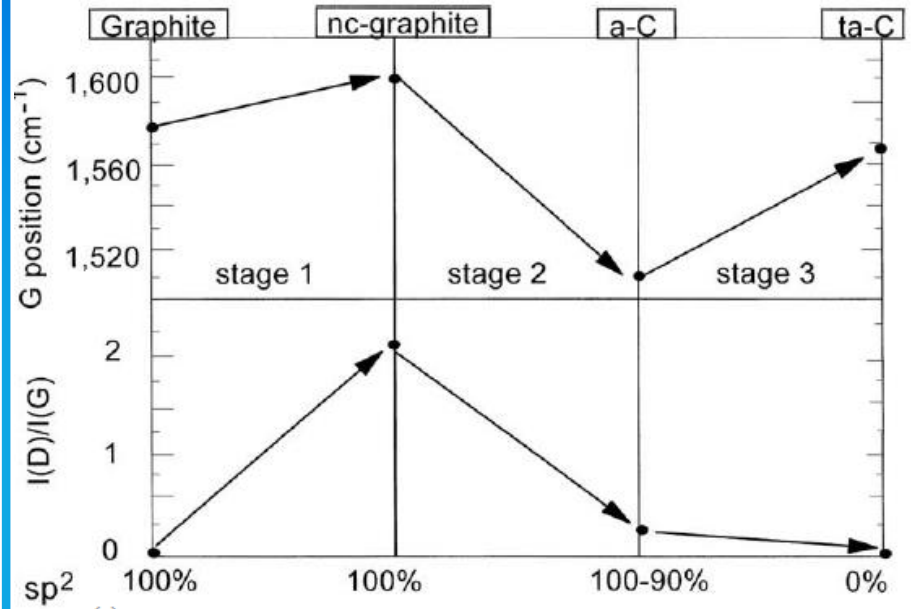
- **G peak** (bond stretching of all pairs of sp^2 atoms in both **rings** and **chains**) $\rightarrow 1560 \text{ cm}^{-1}$
- **D peak** (breathing modes of sp^2 atoms in **rings**) $\rightarrow 1360 \text{ cm}^{-1}$



Under UV laser excitation

T peak (C-C sp^3 vibrations) $\rightarrow 1060 \text{ cm}^{-1}$

Three-stage model



A. C. Ferrari and J. Robertson,
Phil. Trans. R. Soc. Lond. A 2004 362, 2477-2512

Decreasing $I_D/I_G \rightarrow$ increasing sp^3

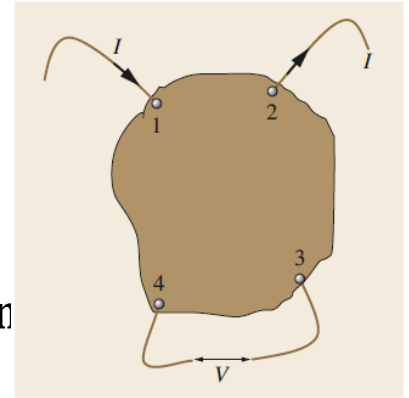
DLC by PLD: electrical measurement technique

Van der Pauw Method to measure electrical resistivity on bulk/films

4-probe technique that involves applying a current and measuring a voltage using four small contacts on a circumference of a flat, arbitrarily shaped sample.

Test Procedure:

- Force Current (I) on adjacent terminals
- Measure Voltage (V) on an opposite pair of adjacent terminals
- Repeat measurements around sample
- Calculate resistivity



$$\rho = \frac{\pi \delta}{\ln 2} \left(\frac{R_{12,43} + R_{23,14}}{2} \right) f \left(\frac{R_{12,43}}{R_{23,14}} \right)$$

The **van der Pauw** contact configuration is also used to measure carrier mobility and concentration by Hall effect (in a magnetic field).

Ohmic contacts are implicitly required ! This can be tricky on high resistivity samples.

Electrical Resistivity at ELPHO

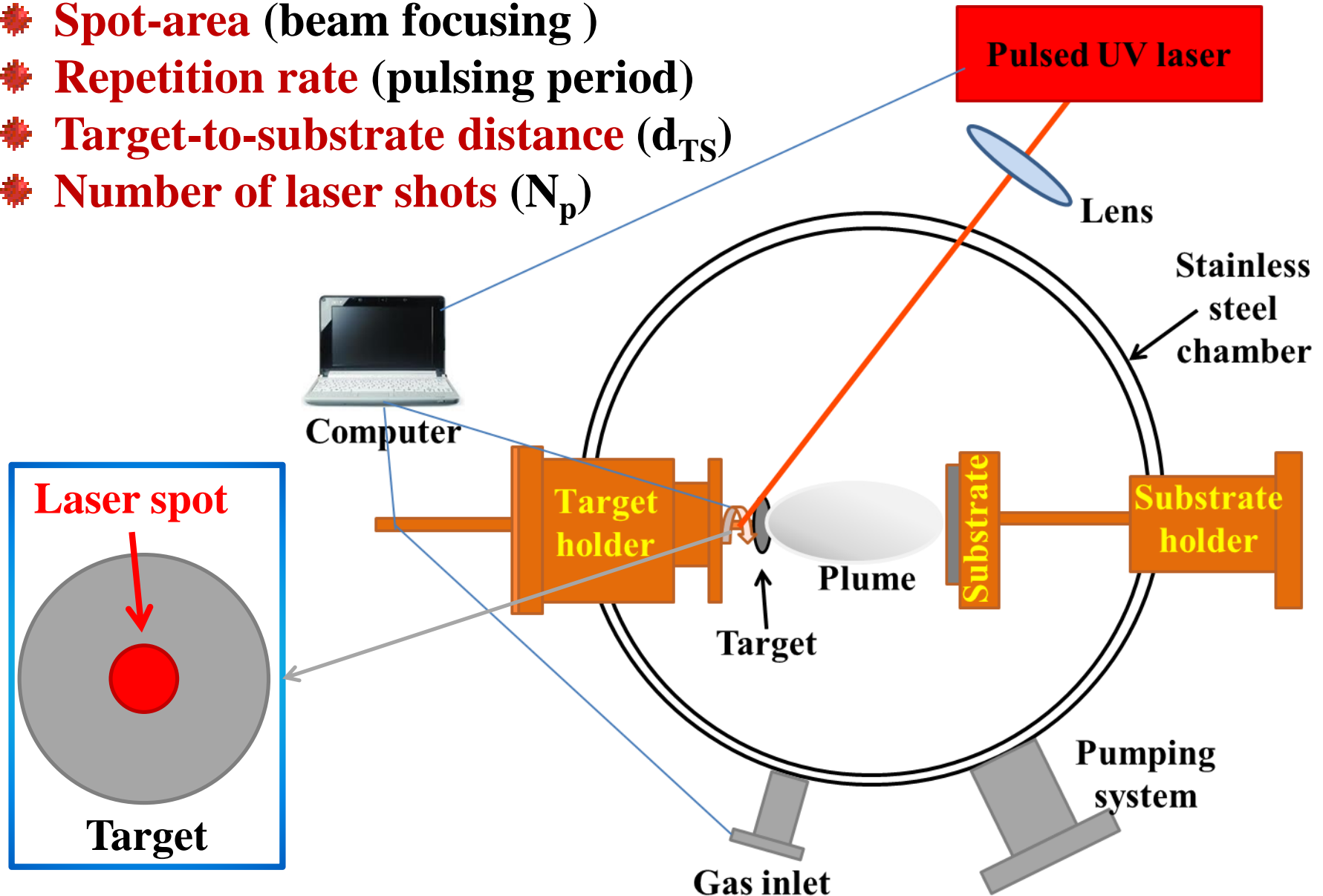
(ELectrical and PHOtoelectrical Laboratory, a CNR joint lab)

- In the ELPHO Lab it is available a Hall Measurement System (**Ecopia HMS-3000**): van der Pauw system for measuring electrical resistivity from 10^{-4} to $10^7 \Omega \text{ cm}$, and, in a $B=0.5\text{T}$, the carrier concentration and mobility.
- In the temperature range 77K-600K we use a liquid nitrogen thermal stage and a vacuum chamber (**Linkam**)
- To measure high resistivity we use multi Source-Monitor-Unit system **Agilent B1500** (input resistance $>10^{13} \Omega$) with guarded (Triax) cables.



PLD: working principle and apparatus

- ✿ **Fluence** (energy per unit surface)
- ✿ **Spot-area** (beam focusing)
- ✿ **Repetition rate** (pulsing period)
- ✿ **Target-to-substrate distance** (d_{TS})
- ✿ **Number of laser shots** (N_p)



DLC: why PLD?

• Hydrogen-free C-materials

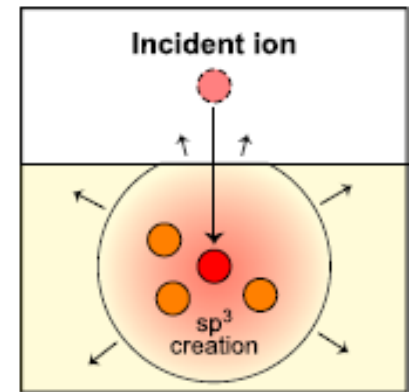
The incorporation of H passivates the dangling covalent bonds of C (C-H bonds) and forms defect states close to E_F

H:DLC is thermally and electrically less stable than hydrogen-free DLC (above 250-300 °C evolution of H from the film and conversion of sp^3 C-C bonds to sp^2 C-C bonds).

• Hyper-thermal deposition flux in high-vacuum

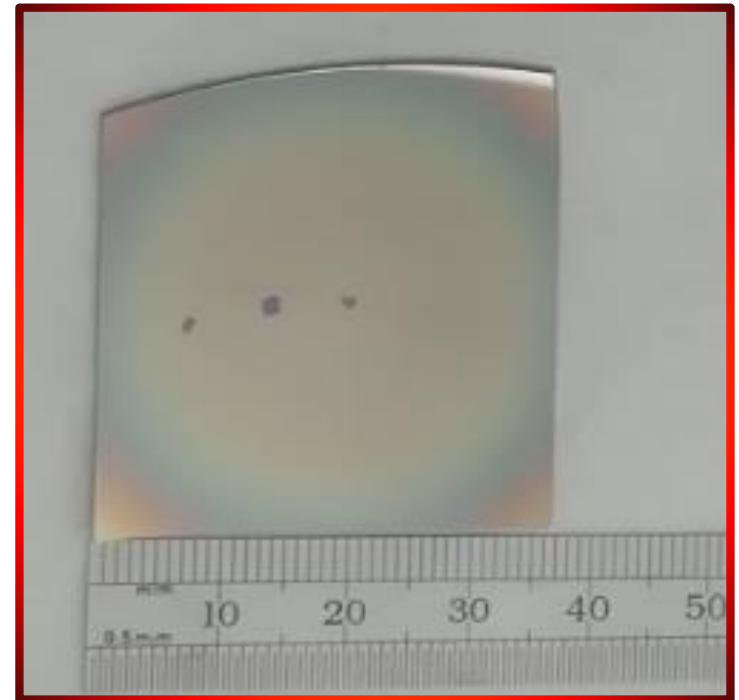
PLD avoids precursor gases containing H and lets grow at low temperature (25-100 °C) by exploiting energetic (60–100 eV) deposition flux containing C-species (ions, neutrals, dimers, clusters) favoring the formation of sp^3 -C bonds ($\rightarrow C^+$).

PLD allows to produce the highest percentage of sp^3 bonds (up to 85-90%) [*Diam. Relat. Mater.* 8, 1659 (1999)] \rightarrow high degree of diamond-like properties.



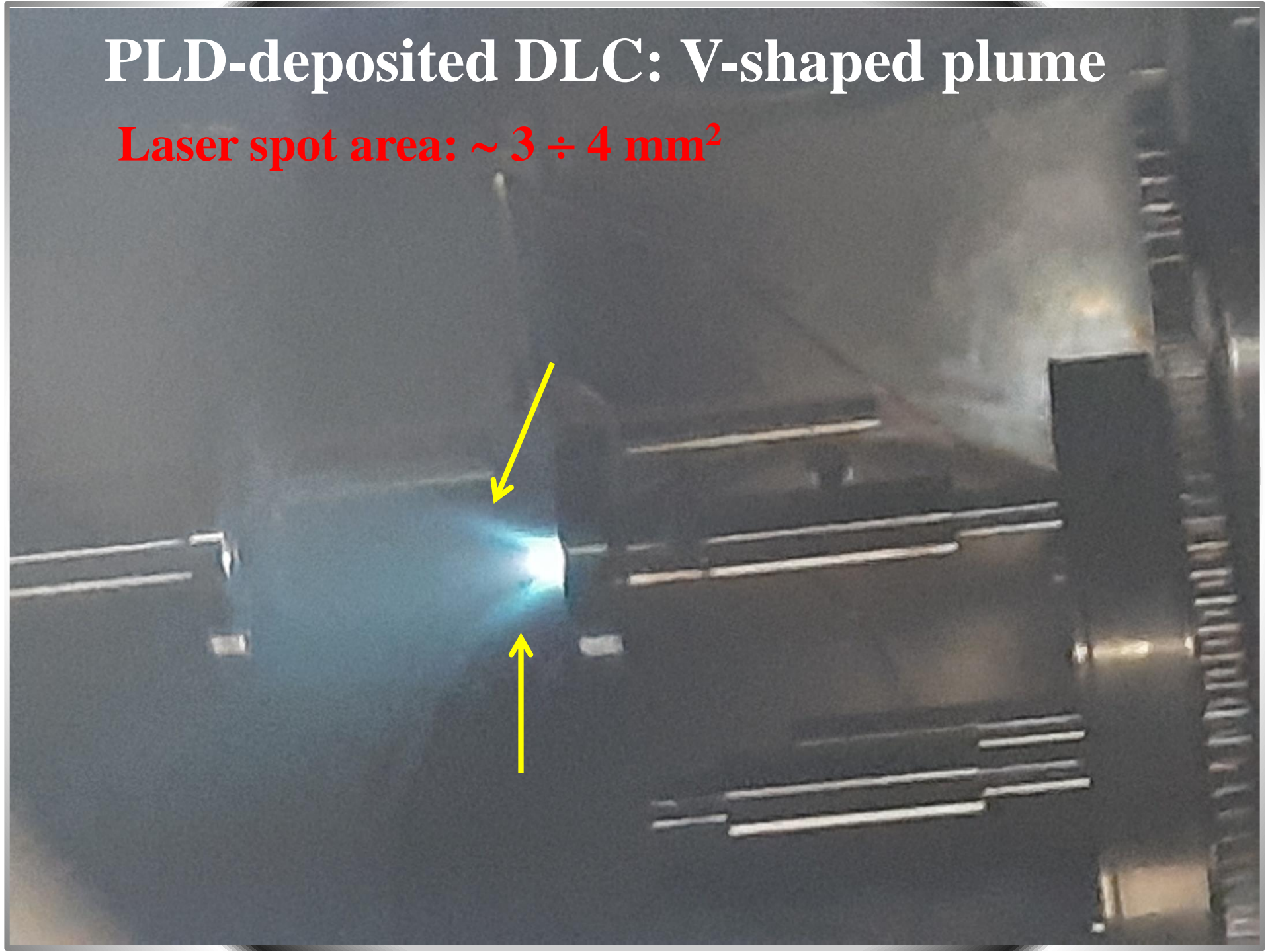
DLC by PLD: aims and characterizations

- **Deposition over a large area & film uniformity**
- **Desired resistivity values**
 - Sheet resistance: $10 \div 100 \text{ M}\Omega/\text{sqr}$**
- **Deposition geometry**
- **Spot area**
- **Fluence tuning**
- **Characterizations**
 - **Raman spectroscopy**
 - **SEM and TEM**
 - **XPS analysis**
 - **Spectrophotometric analysis**
 - **Electrical properties**



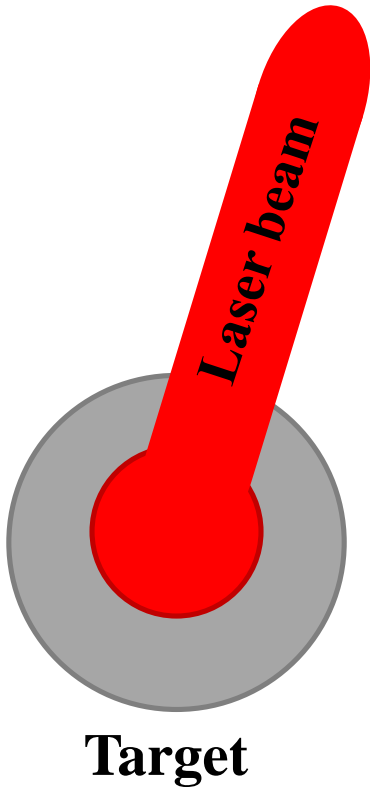
PLD-deposited DLC: V-shaped plume

Laser spot area: $\sim 3 \div 4 \text{ mm}^2$

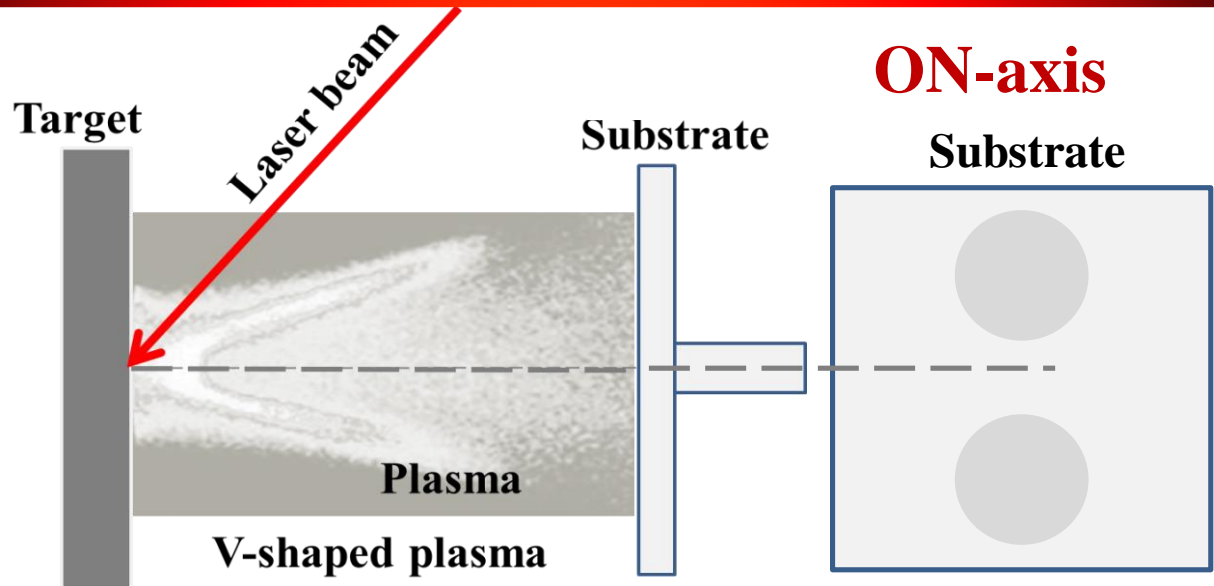


PLD: OFF-axis vs ON-axis

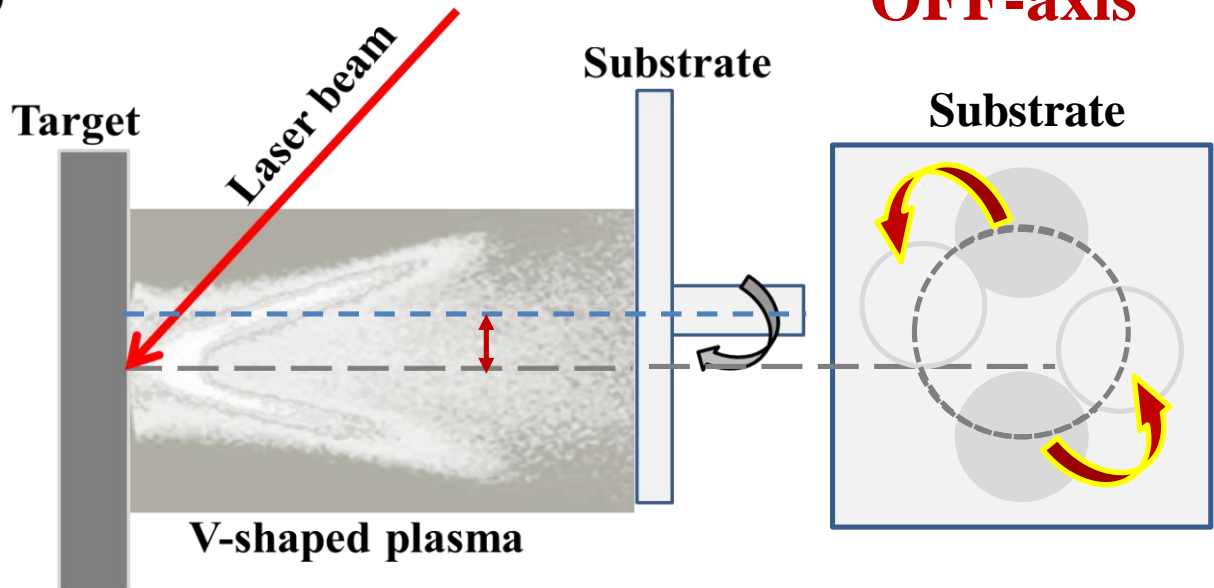
**LARGE
spot-area**



(a)



(b)



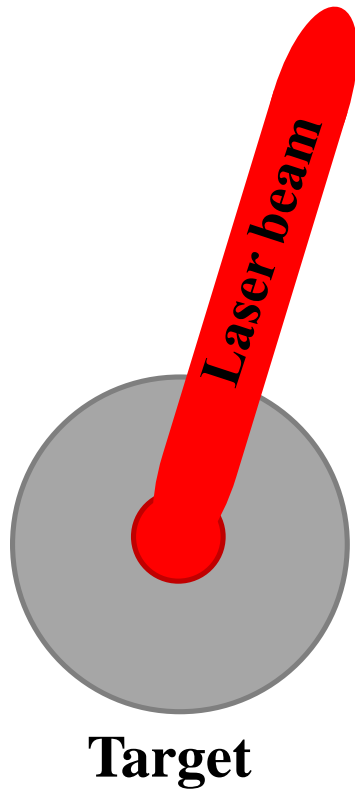


Laser spot area: $\sim 0.9 \div 1.6 \text{ mm}^2$

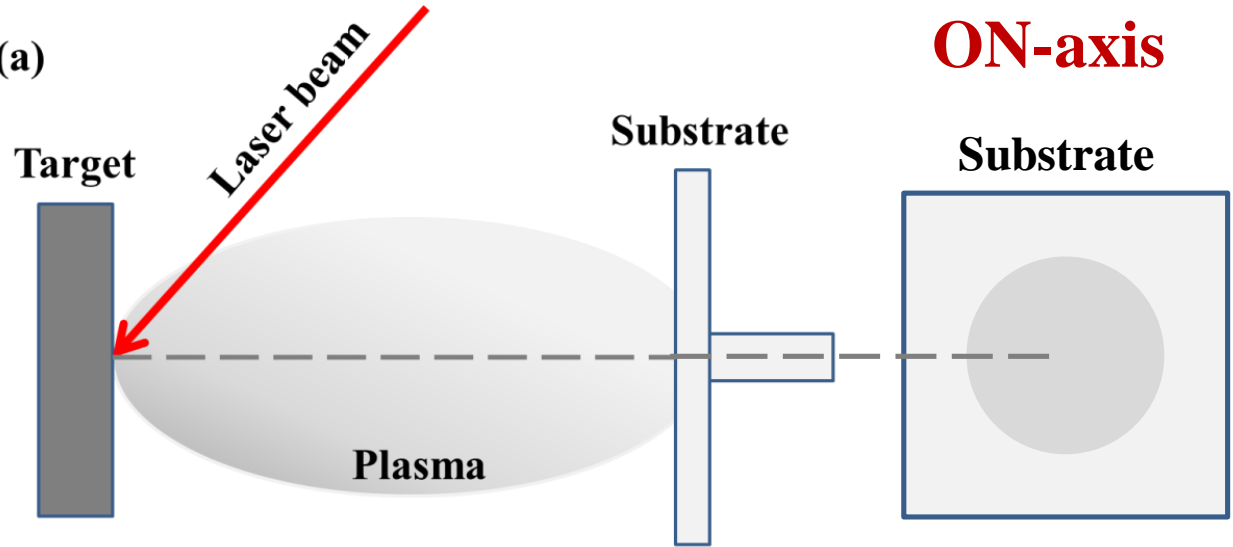
**PLD-deposited DLC:
conventional (ellipsoidal) plume**

PLD: OFF-axis vs ON-axis

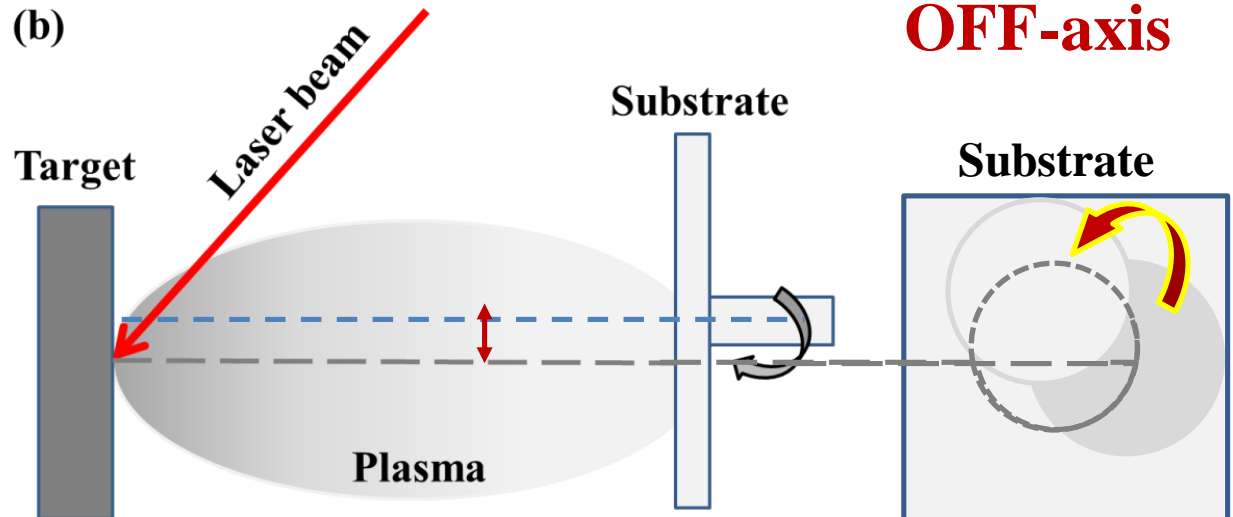
**SMALL
spot-area**

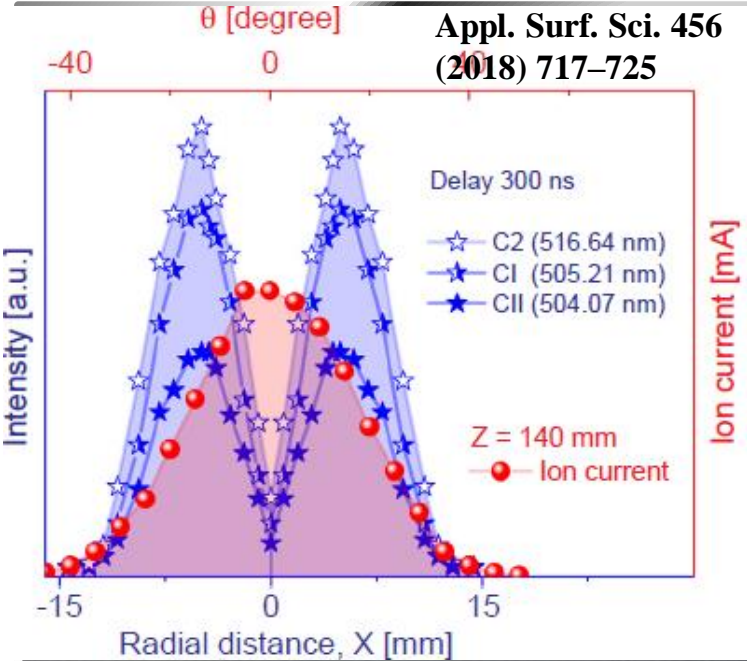


(a)

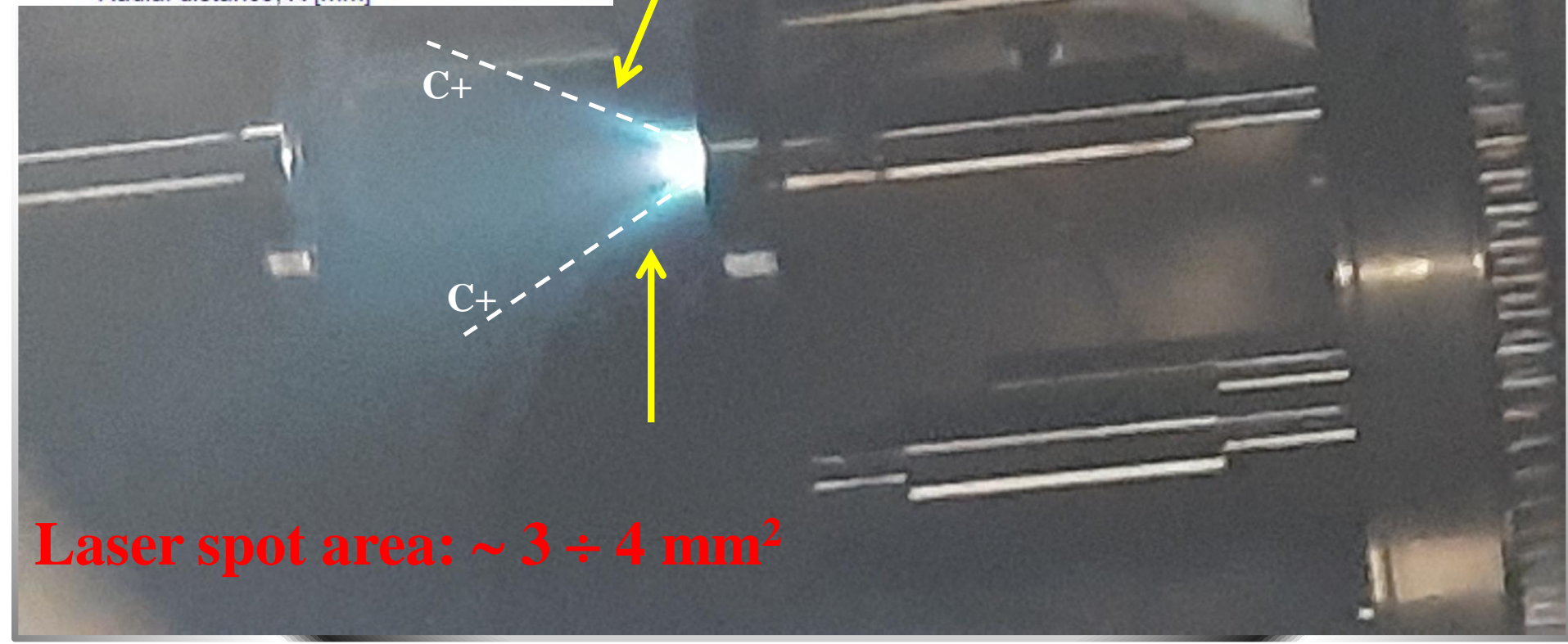


(b)





PLD-deposited DLC: V-shaped plume



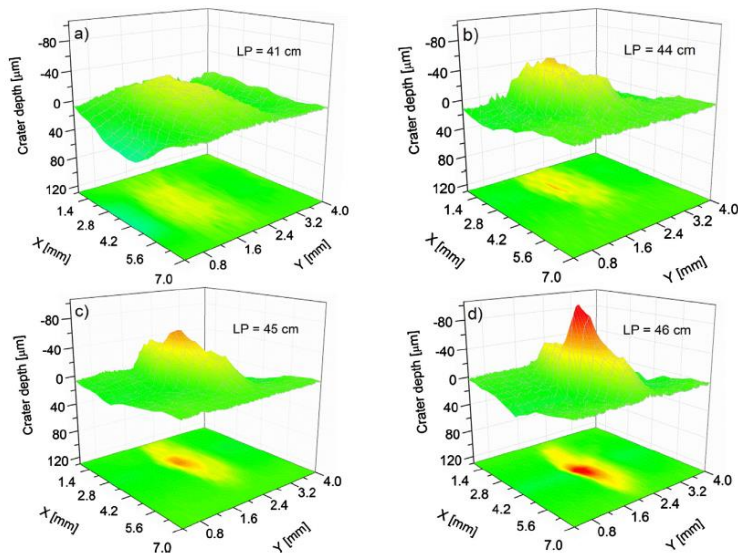
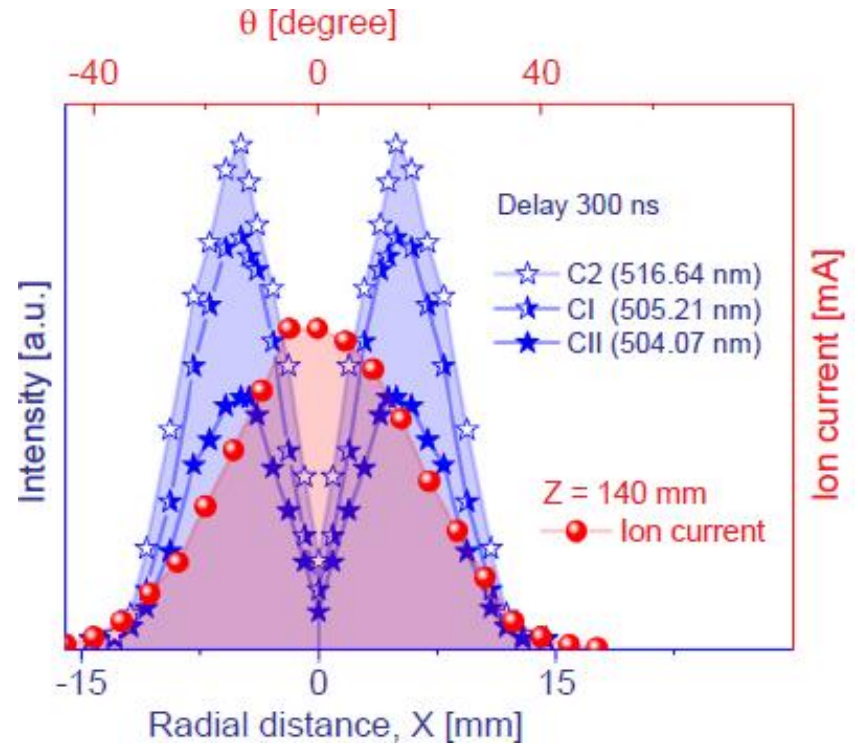
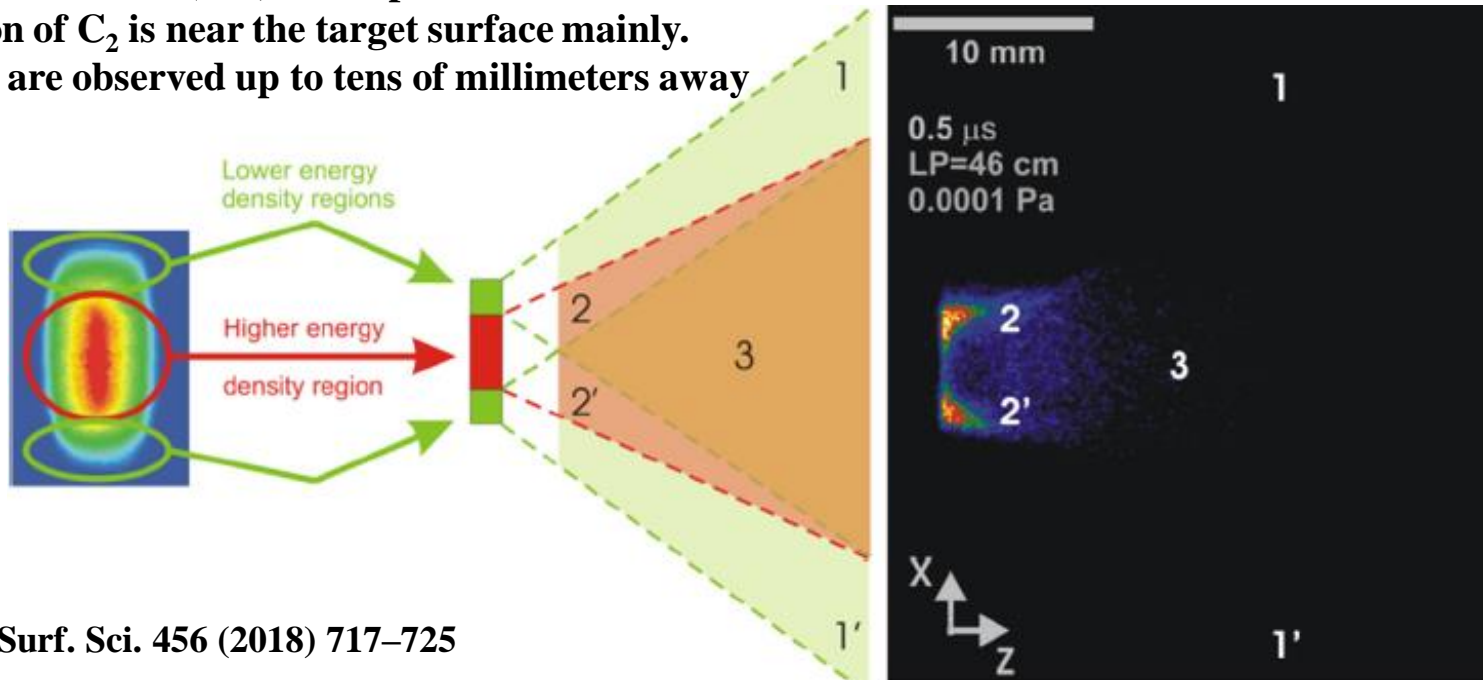


Fig. 4. Laser ablation crater depth profiles as a function of the beam focusing.

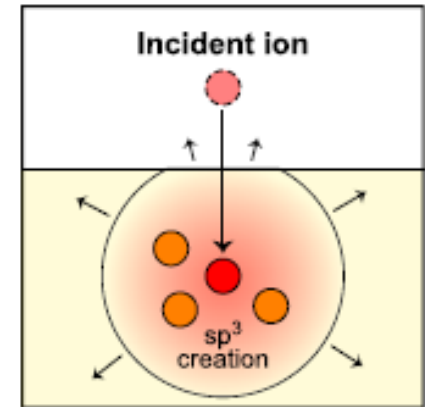
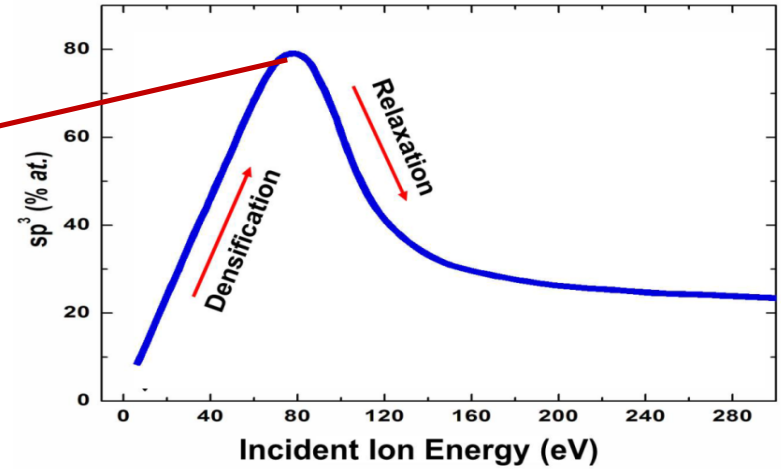
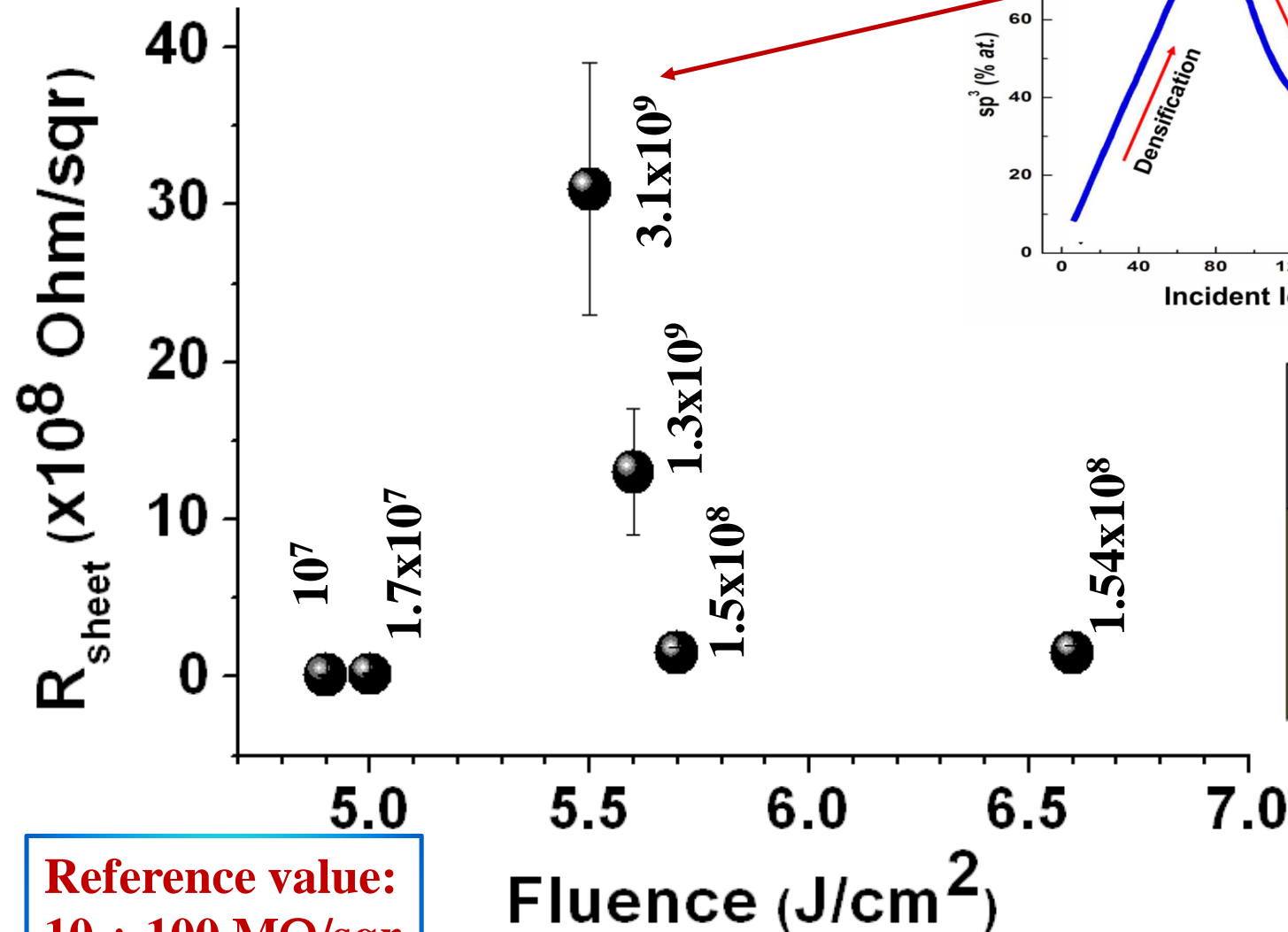


Dominance of C_2 molecules over neutral (CI) and singly-ionized atoms (CII) in the plasma lateral arms.
Emission of C_2 is near the target surface mainly.
CI and CII are observed up to tens of millimeters away



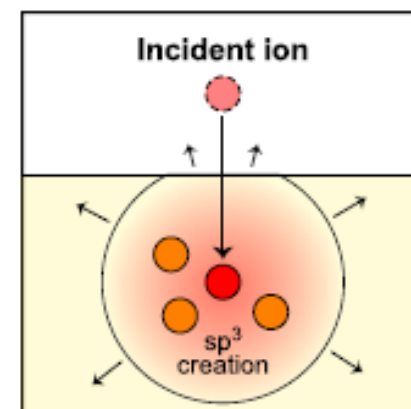
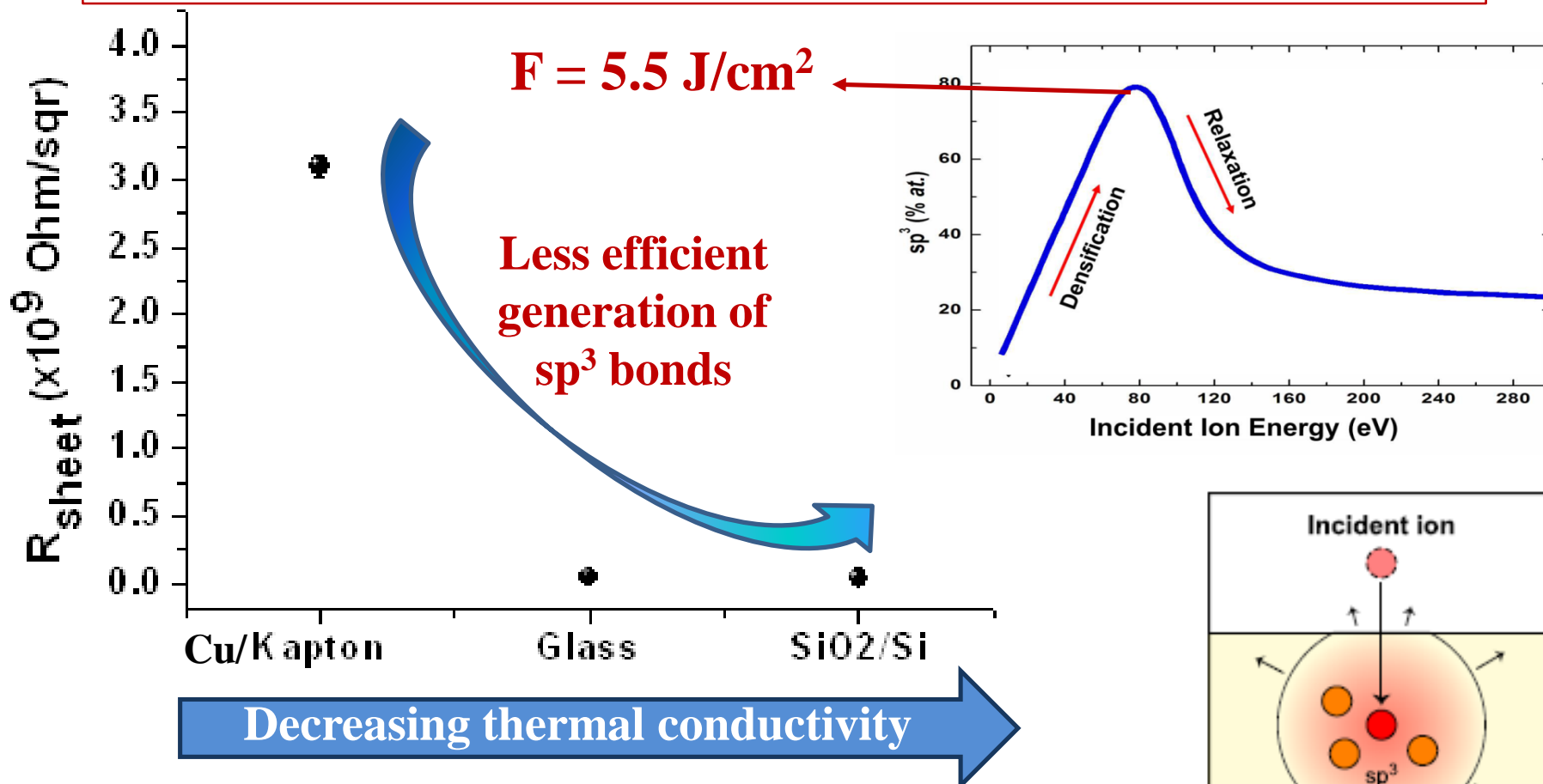
DLC by PLD: large spot, OFF-axis/rot, Cu/Kapton substrate

Threshold fluence: $F = 5.5 \text{ J/cm}^2$



Reference value:
 $10 \div 100 \text{ M}\Omega/\text{sqr}$

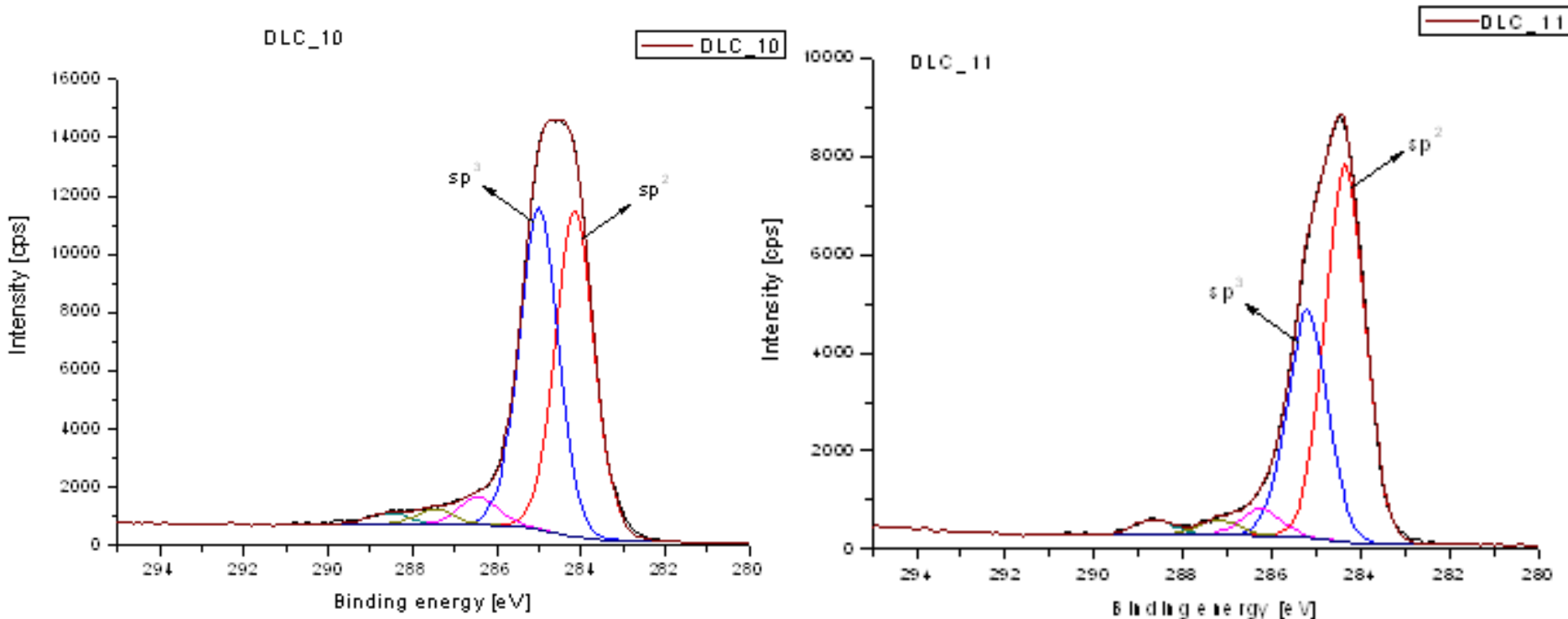
DLC by PLD (large spot, OFF-axis): SUBSTRATE



Shots	Spot	d_{TS}	Substrate	R_{sheet} (Ω/sqr)
8000	3.9 mm ²	5.5 cm	Kapton (50μm)/Cu(5μm)	3.1 x10⁹
7116	3.9 mm ²	5 cm	Silica-glass	6.5 x10⁷
7000	3.6 mm ²	5.5 cm	SiO₂(100 nm)//Si	3.1 x10⁶

J. Robertson. Japanese Journal of Applied Physics, 50:01AF01, 2011.

DLC by PLD: XPS elemental-bonding analysis

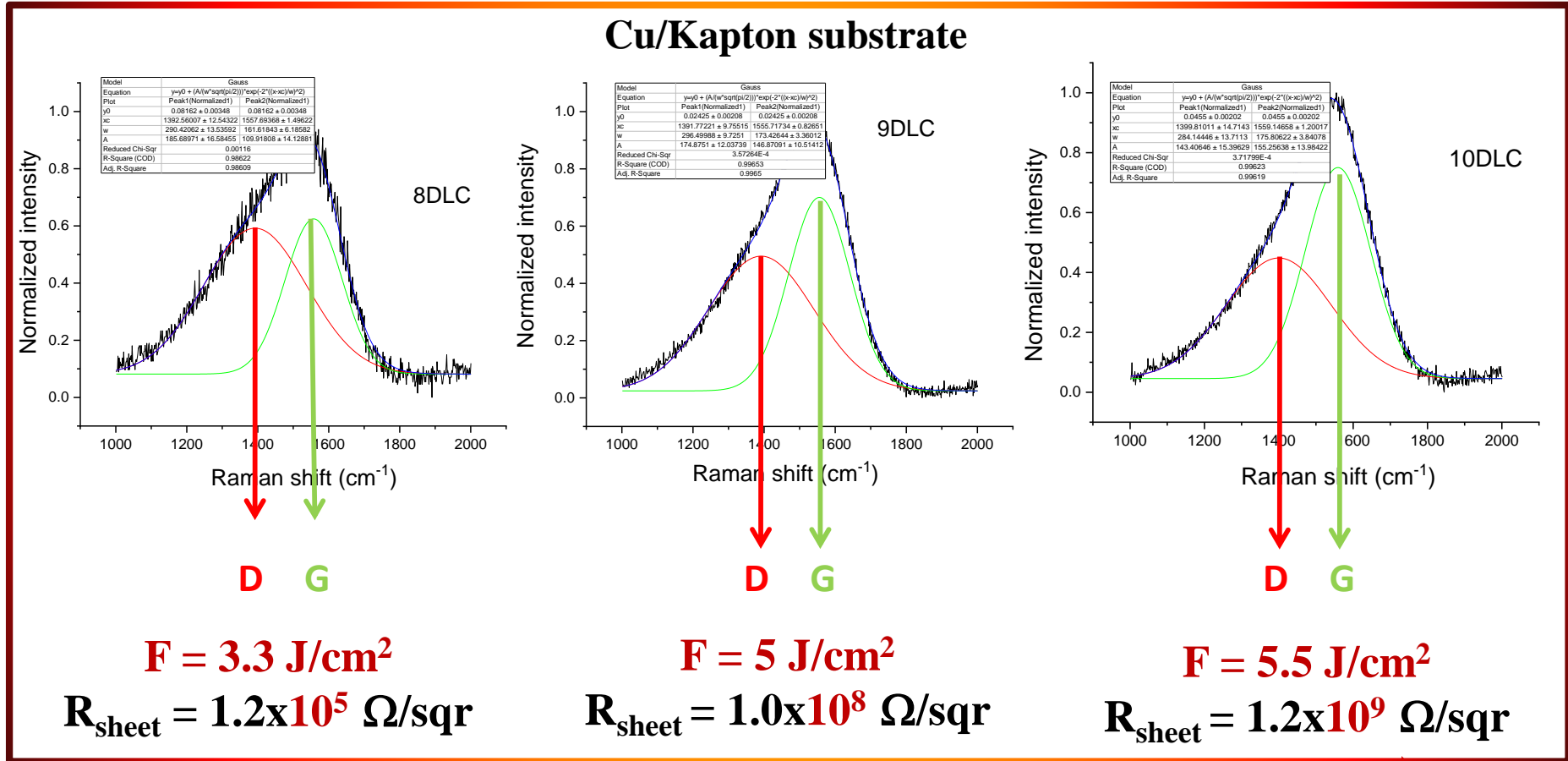


Sample	d_{TS} (cm)	A_{Spot} (mm ²)	N_p	F(J/cm ²)	Substrate	Energy (J)	sp^3
# 10	5	4.0	8000	4.8	Cu/Kapton	0.192	49.7 %
# 11	5.5	3.4	8000	5.2	Cu/Kapton	0.177	37.5 %

Energy delivered per pulse \rightarrow fraction of sp^3 bonds

DLC by PLD: visible RAMAN spectroscopy

Fluence dependence of I_D/I_G (sp^3 bonding / resistivity)



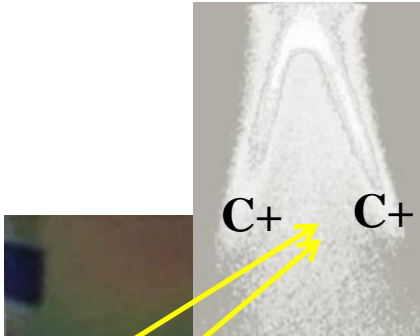
Decreasing $I_D/I_G \rightarrow$ increasing sp^3

DLC by PLD: large spot /ON-axis vs OFF-axis

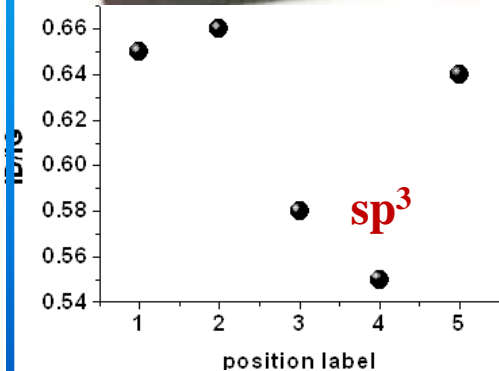
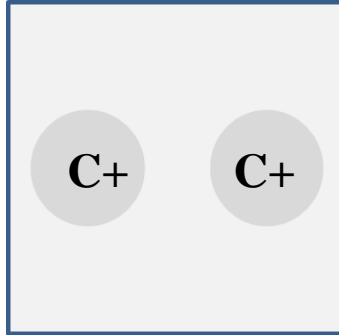
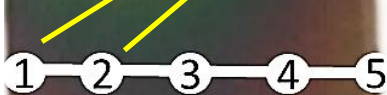
DLC-28 (Si/SiO₂ (100 nm))

F=5.5 J/cm² N_p= 7000

d_{TS}=5.5 cm Spot=3.6 mm²



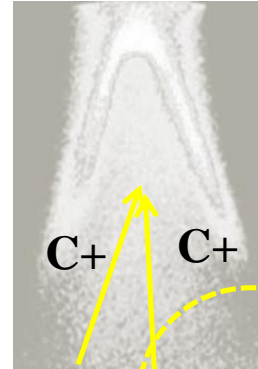
**ON-axis
Unrot**



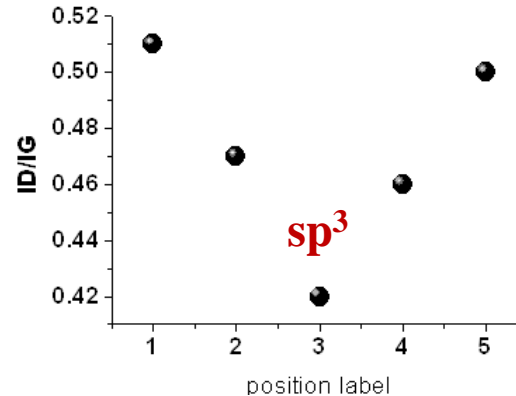
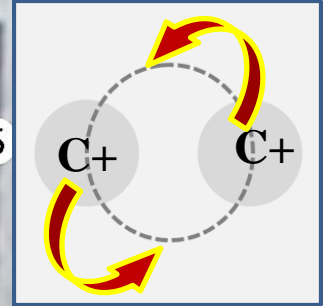
DLC-25 (Si/SiO₂ (100 nm))

F=5.5 J/cm² N_p= 7116

d_{TS}=5 cm Spot=3.9 mm²



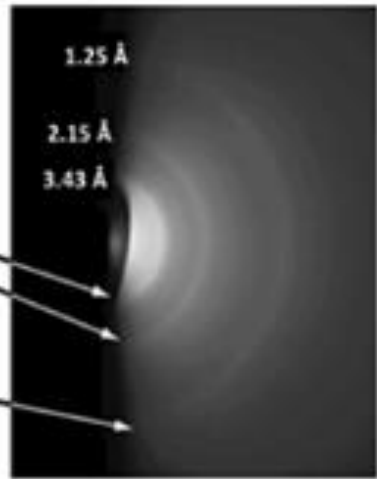
**OFF-axis
Rot. Sub.**



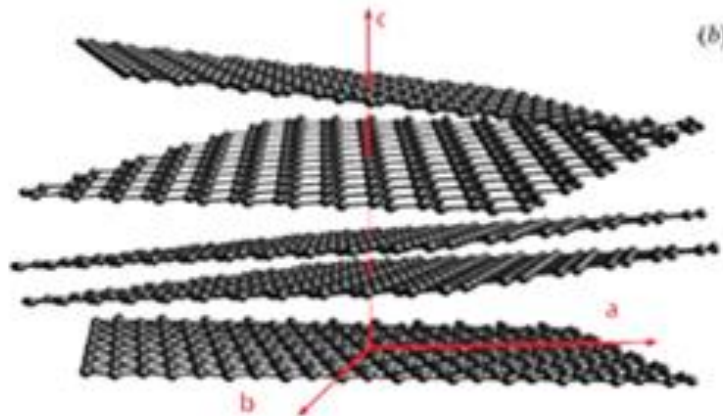
$R_{\text{sheet}} = (3.1 \pm 0.3) \times 10^6 \Omega/\text{sqr}$ \longrightarrow $R_{\text{sheet}} = (6.5 \pm 2.3) \times 10^7 \Omega/\text{sqr}$

DLC by PLD: structural TEM analysis

GRAPHITE	
hexagonal, P63/mmc (194)	
JCPDS card 41 - 1487	
d spacing (Å)	hkl
3.3756	002
2.1387	100
2.0390	101
1.8074	102
1.6811	004
1.5478	103
1.2341	110
1.1604	112
1.1208	006
1.0567	201



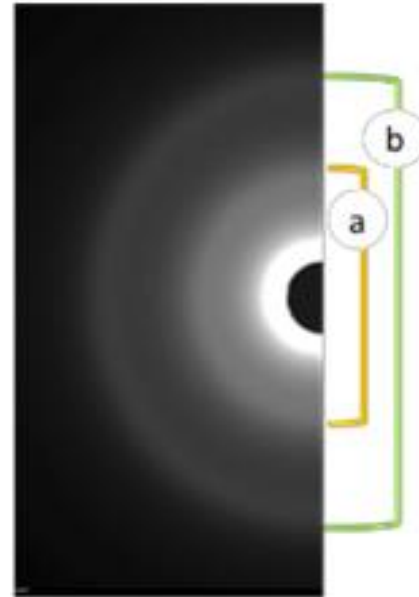
Turbostratic graphite



(b)

DIAMOND	
Fd3m	
JCPDS card 79-1467	
d spacing (Å)	hkl
a 2.059	111
b 1.261	220

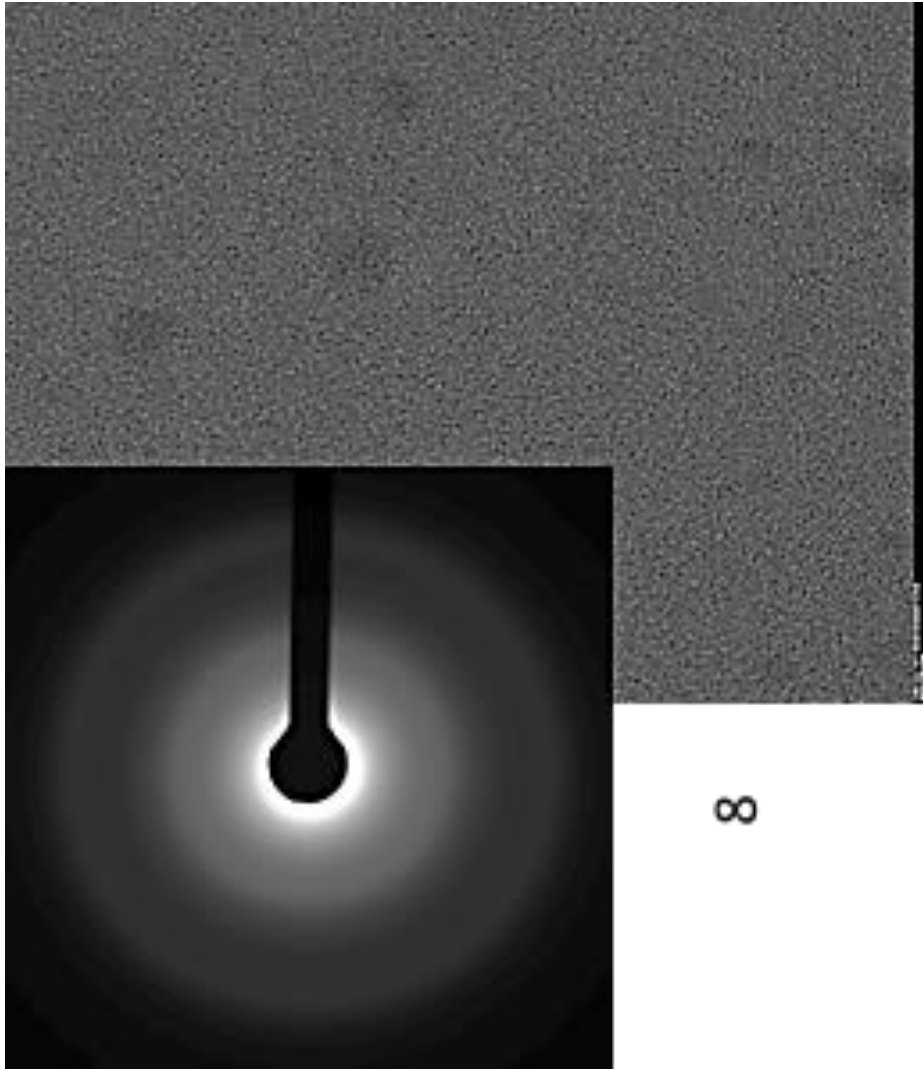
GRAPHITE	
P63/mmc	
JCPDS card 41-1487	
d spacing (Å)	hkl
3.357	002
a 2.023	101
1.678	004
1.540	103
b 1.225	110



DLC-9 (Cu/Kapton)
 $F = 4.8 \text{ J/cm}^2$ $N_p = 4000$
 $d_{TS} = 5 \text{ cm}$ $\text{Spot} = 4.1 \text{ mm}^2$

Two rings are clearly visible compatible with both the diffraction maxima 111 and 220 of **diamond**, and with the diffraction maxima 101 and 110 of **graphite**. Overlapping of nano-graphene (missing the ring corresponding to the planes 002 of the graphite) and nano-diamond.

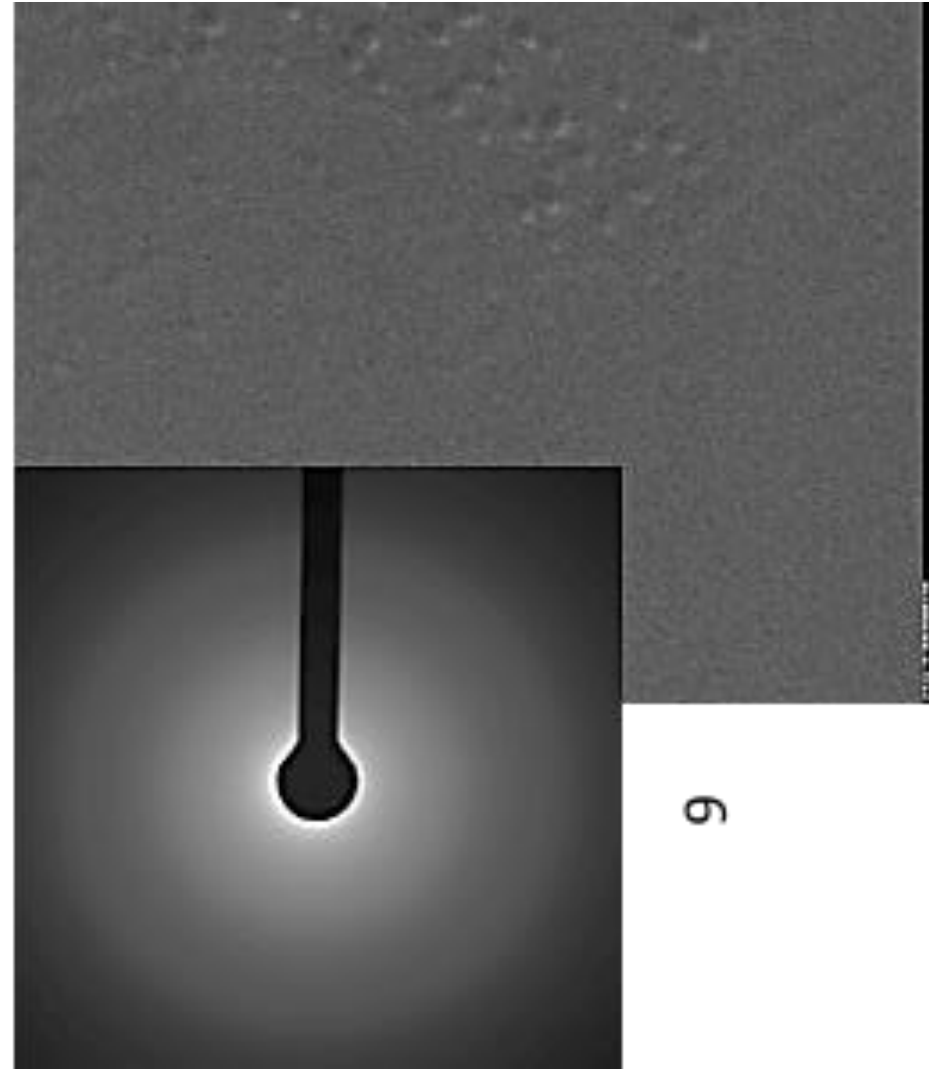
DLC by PLD: structural TEM analysis



DLC-8 (Cu/Kapton)

$F = 3.3 \text{ J/cm}^2$ $N_p = 8000$

$d_{TS} = 5 \text{ cm}$ Spot = 5.4 mm^2



DLC-9 (Cu/Kapton)

$F = 4.8 \text{ J/cm}^2$ $N_p = 4000$

$d_{TS} = 5 \text{ cm}$ Spot = 4.1 mm^2

PLD-deposited DLC: conventional (ellipsoidal) plume

$$n(r, \theta) = \frac{C}{r^2} (\cos \theta)^m$$

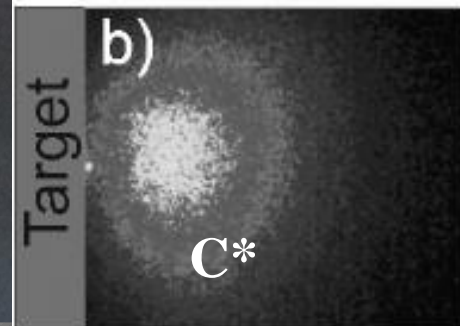
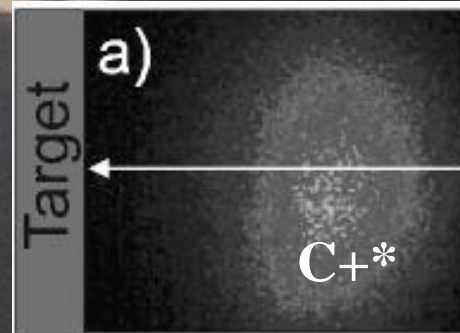
Laser spot area: $\sim 1 \text{ mm}^2$

Laser Fluence: $5.5 \div 18 \text{ J/cm}^2$

Number of laser pulses: $28000 \div 35000$

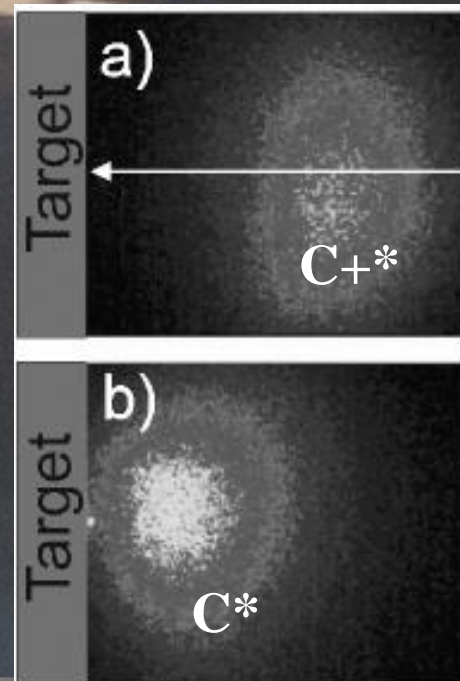
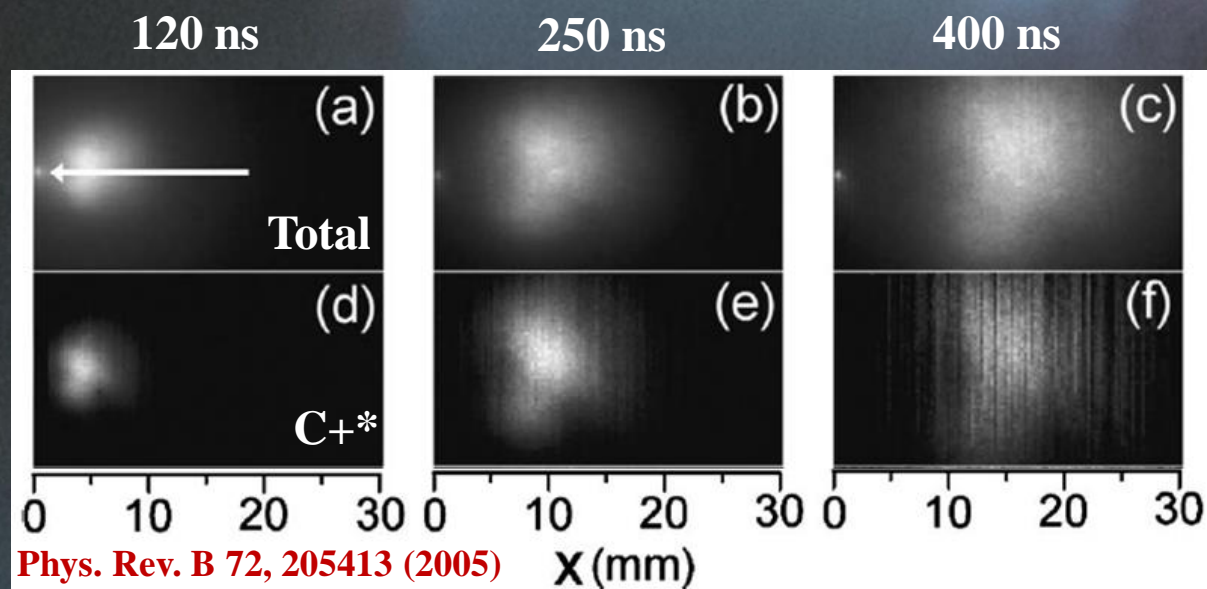
Target-to-substrate distance: $d_{TS}: 55 \div 45 \text{ mm}$

Chem. Soc. Rev.
33, 23–31 (2004)



PLD-deposited DLC: conventional (ellipsoidal) plume

Chem. Soc. Rev.
33, 23–31 (2004)

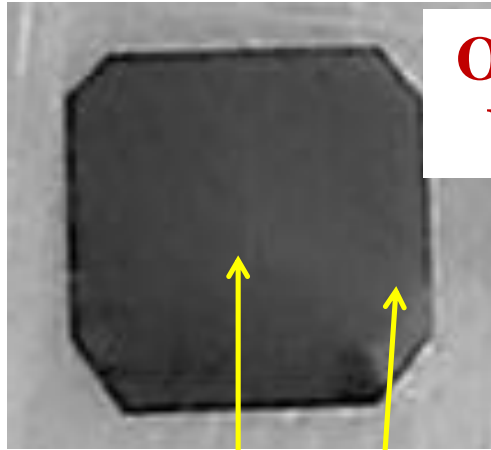


DLC by PLD: small spot /ON-axis vs OFF-axis

DLC-30 (Si/SiO₂ (100 nm))

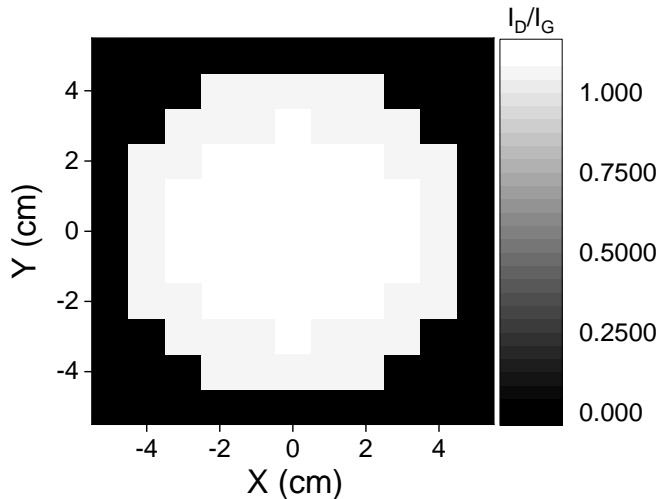
F = **5.5 J/cm²** N_p = 7000

d_{TS} = 5.5 cm Spot = 0.9 mm²



**ON-axis
Unrot**

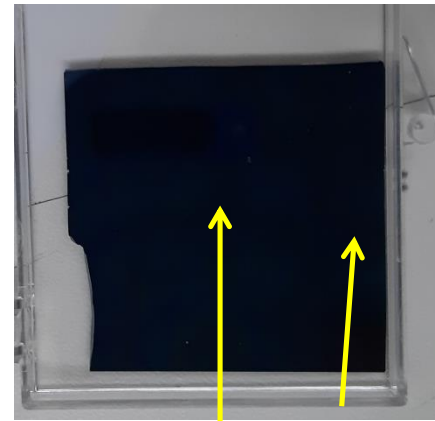
1.15 1.08



DLC-36 (Si/SiO₂ (100 nm))

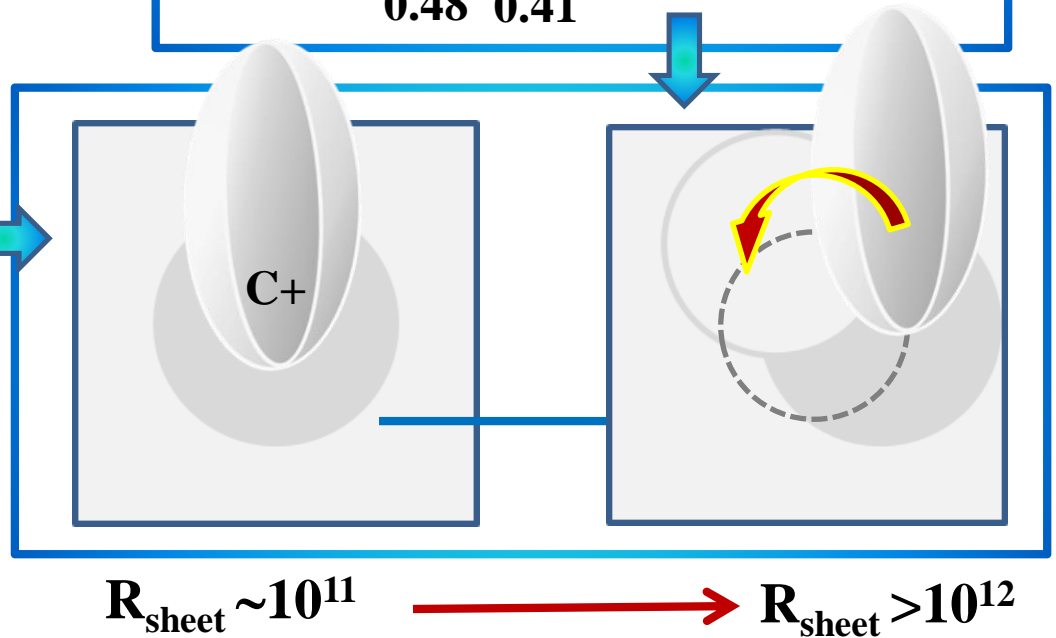
F = **5.5 J/cm²** N_p = 7000

d_{TS} = 4.4 cm Spot = 1.5 mm²

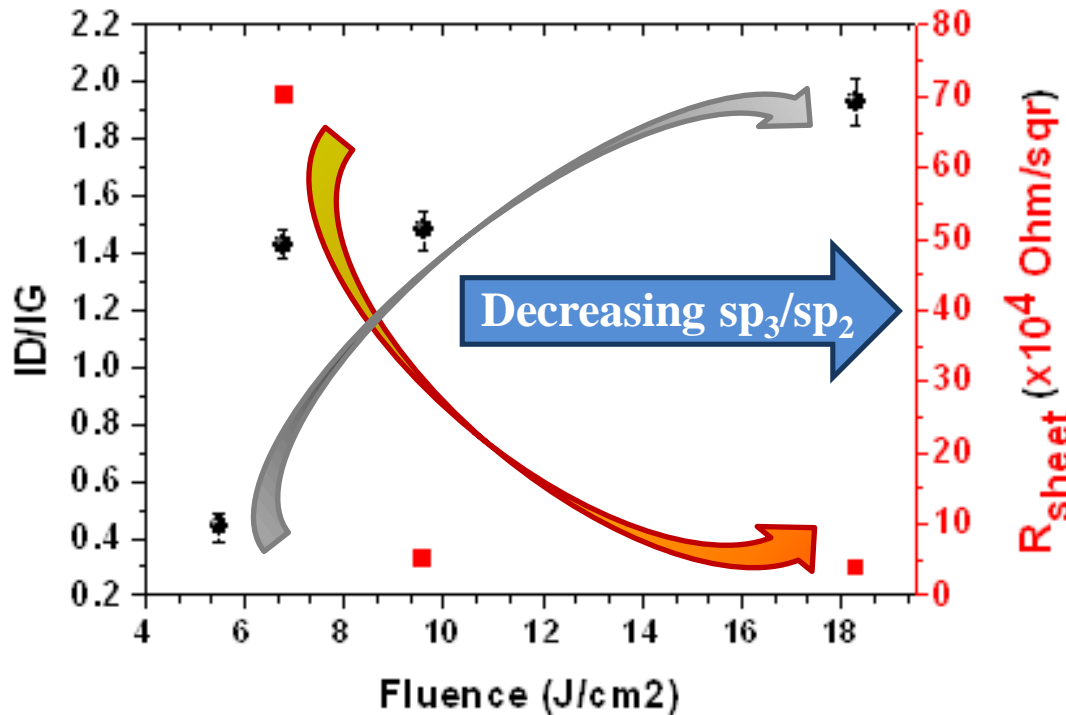
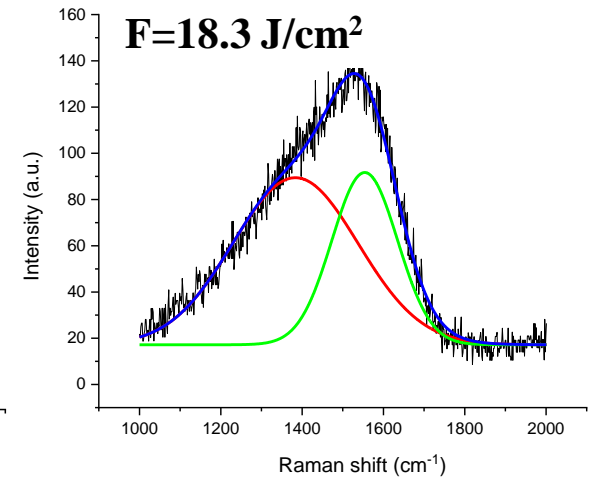
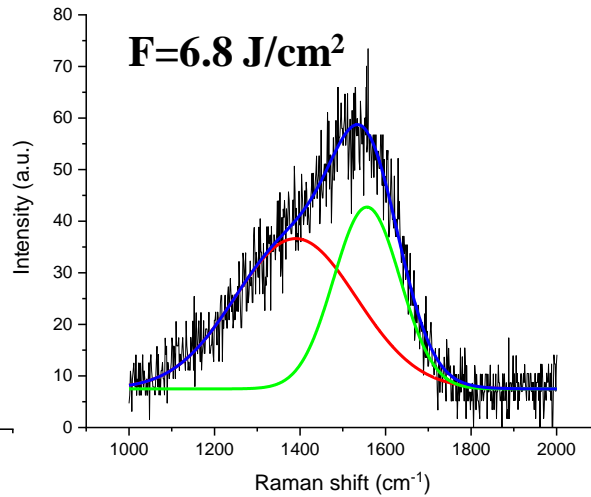
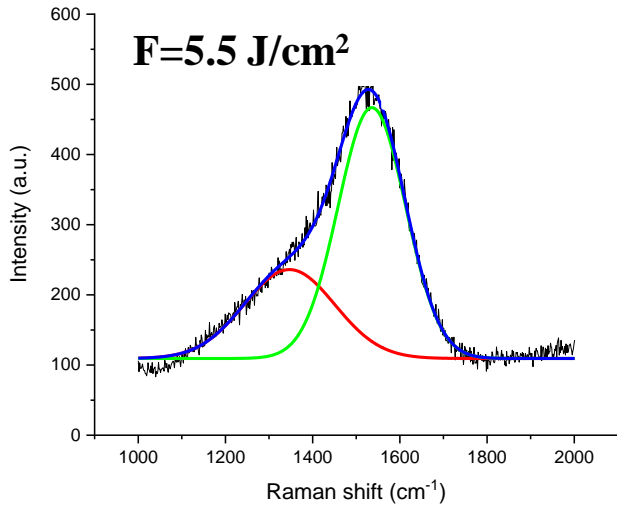


**OFF-axis
Rot**

0.48 0.41



DLC by PLD: fluence-dependent sp^3 bonding



**For increasing fluence:
 sp_3/sp_2 ratio
and R_{sheet}
decrease**

$R_{\text{sheet}} (5.5 \text{ J/cm}^2) \sim 10^{12} \text{ } \Omega/\text{sqr}$

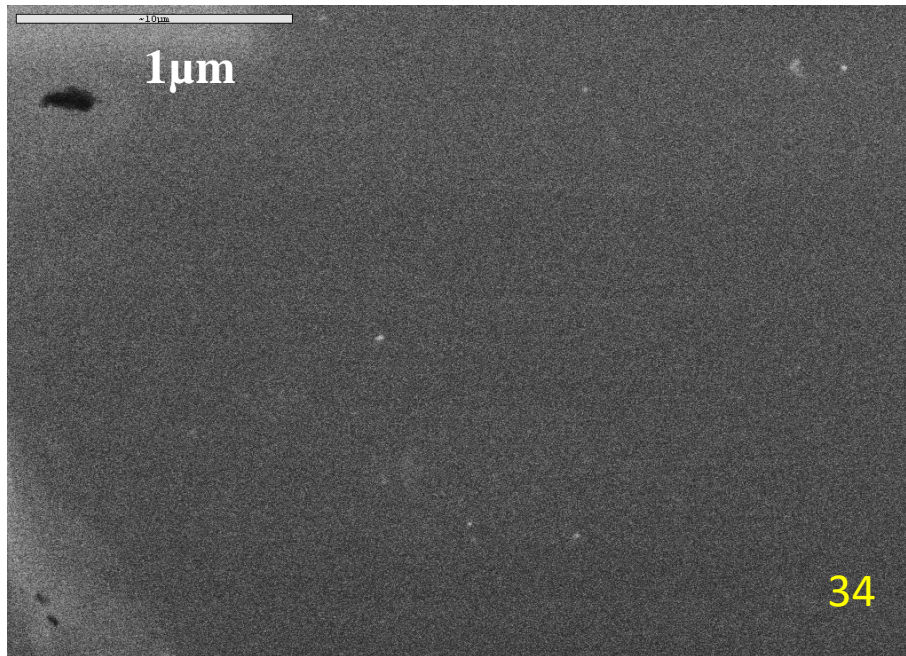
DLC by PLD: XPS and SEM analyses

DLC-34 (Si/SiO₂ (100 nm))

F = **18.3 J/cm²** N_p = 28000

d_{TS} = 4.2 cm Spot = 1.3 mm²

Thickness = (175 ± 10) nm



DLC-38 (Si/SiO₂ (100 nm))

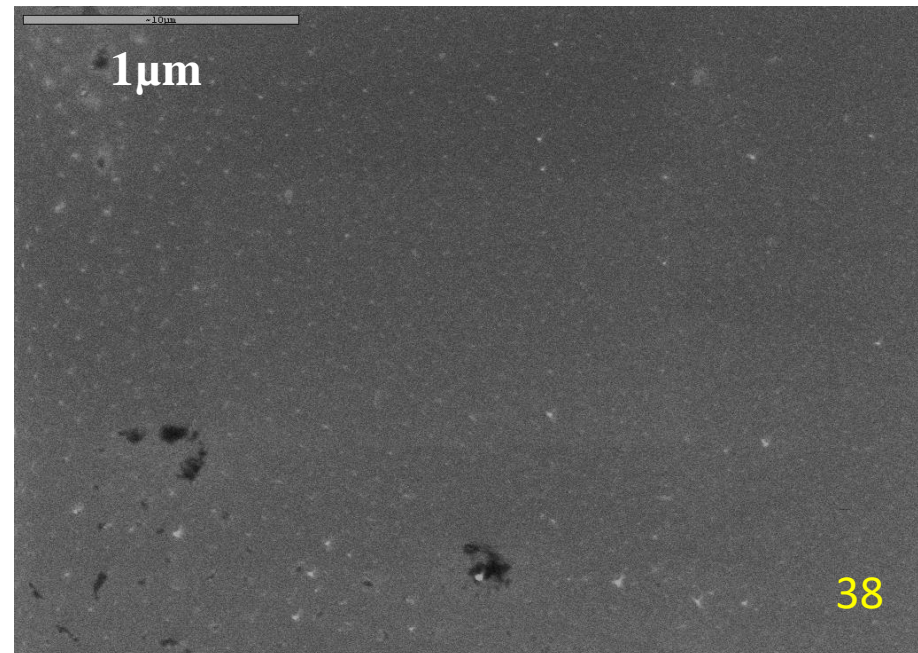
F = **6.8 J/cm²** N_p = 35000

d_{TS} = 3.8 cm Spot = 1.6 mm²

Thickness = (35 ± 10) nm

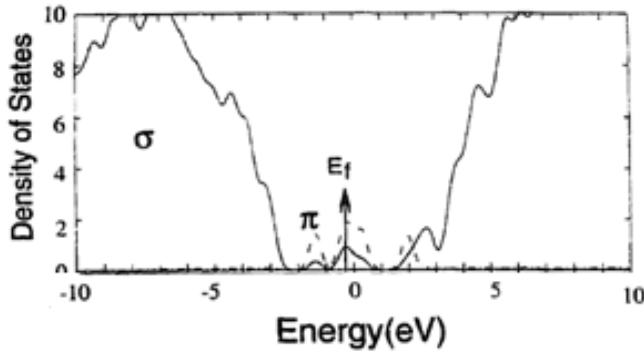
XPS: **sp³ -> 29.6 %**

sp² -> 70.4 %

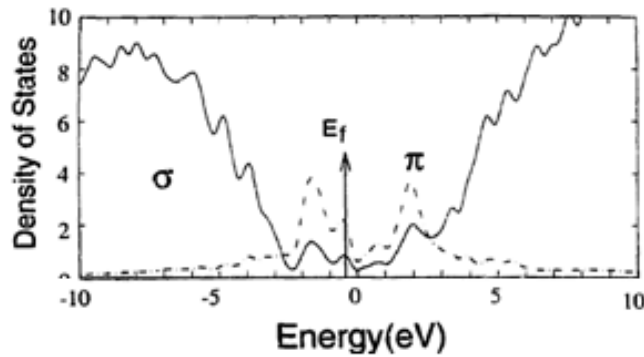


DLC by PLD: electrical properties

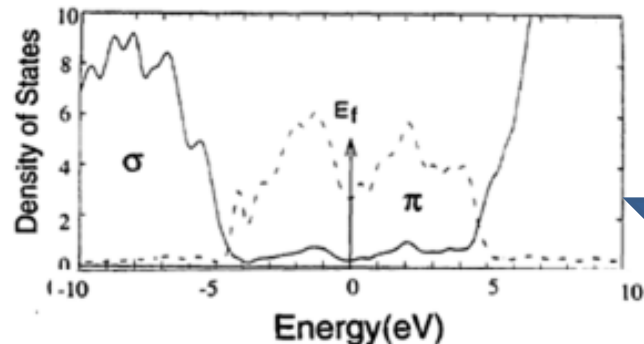
92 % sp^3 bonding



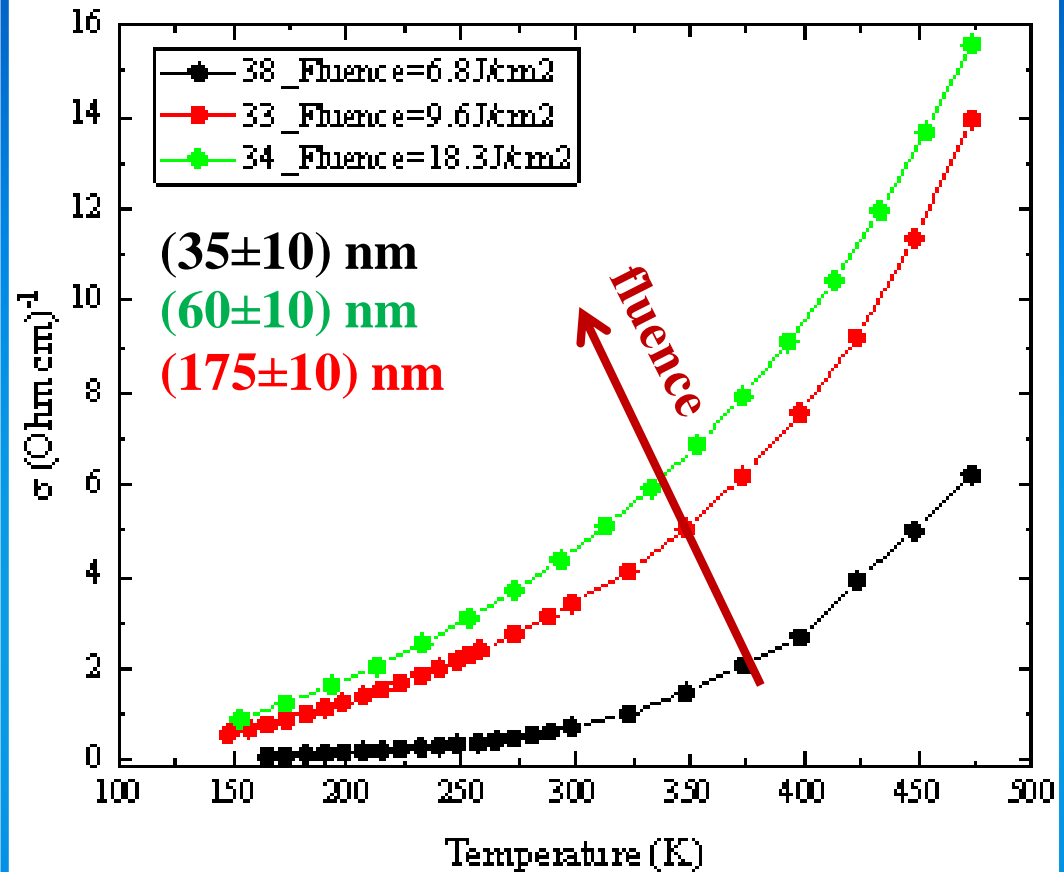
69 % sp^3 bonding



20 % sp^3 bonding

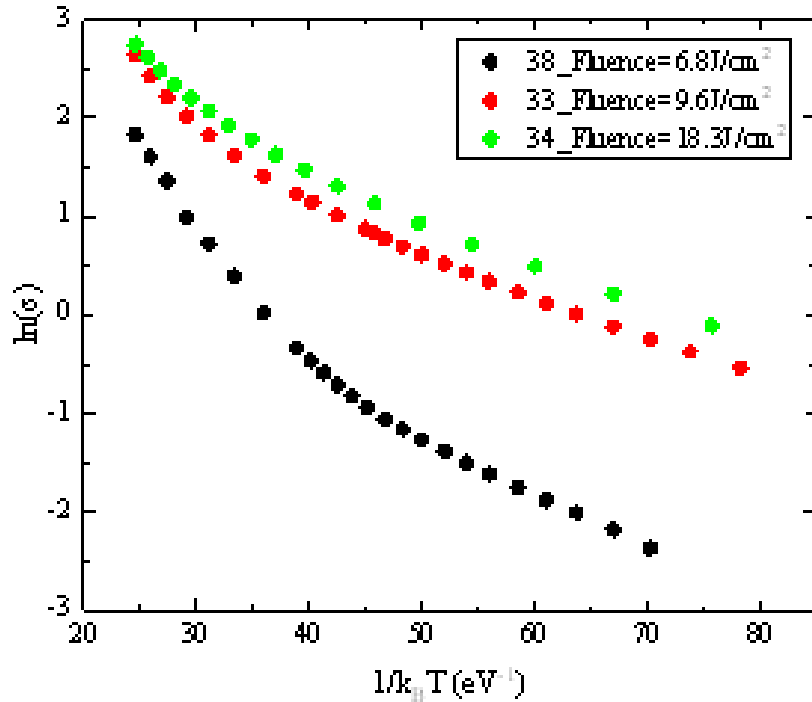


Increasing conductivity



Room temperature conductivity
 σ (6.8 J/cm^2) = 8.77×10^{-1} (Ωcm) $^{-1}$
 σ (9.6 J/cm^2) = 3.22 (Ωcm) $^{-1}$
 σ (18.3 J/cm^2) = 4.42 (Ωcm) $^{-1}$

DLC by PLD: electrical properties

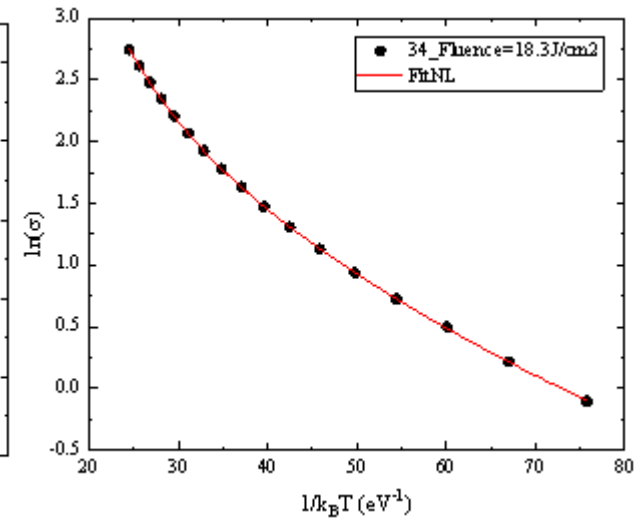
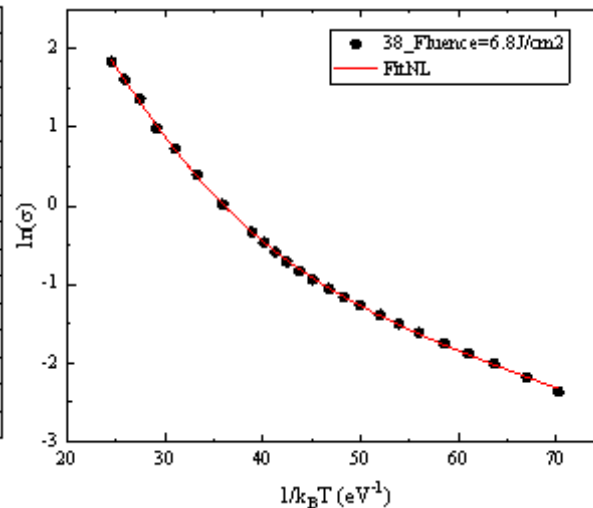
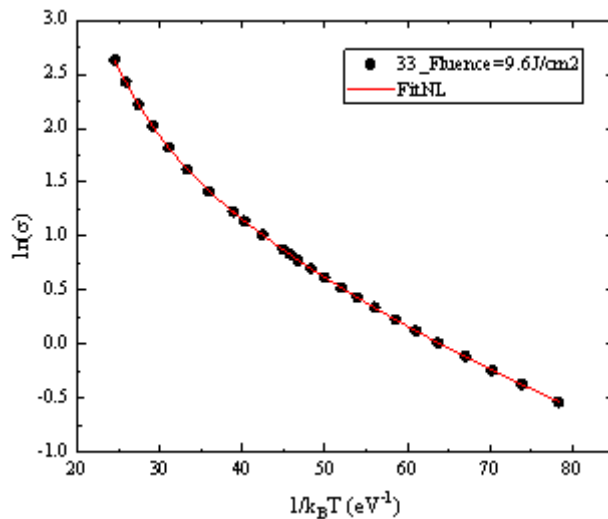


**Conduction mechanisms:
thermal activation involving
localized and tail states**

High T $\sigma_{dc}(T) = \sigma_o \exp(-E_\sigma/k_B T)$

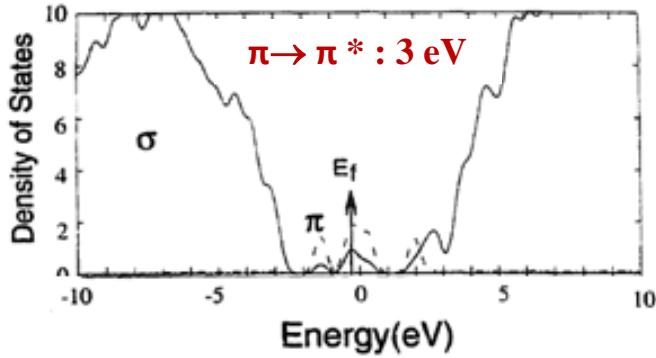
Low T: VRH $\sigma_{dc}(T) = \sigma_o \exp[-(T_o/T)^{1/4}]$

Study in progress...

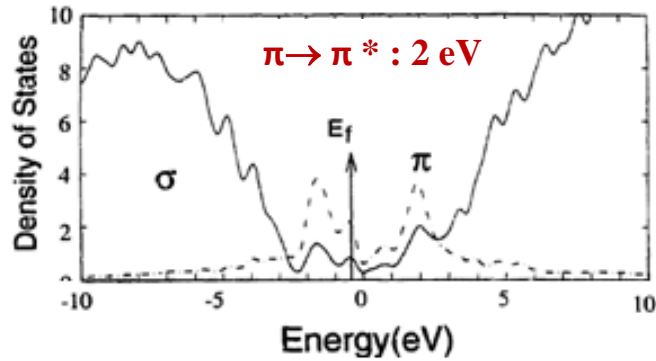


DLC: conduction mechanisms

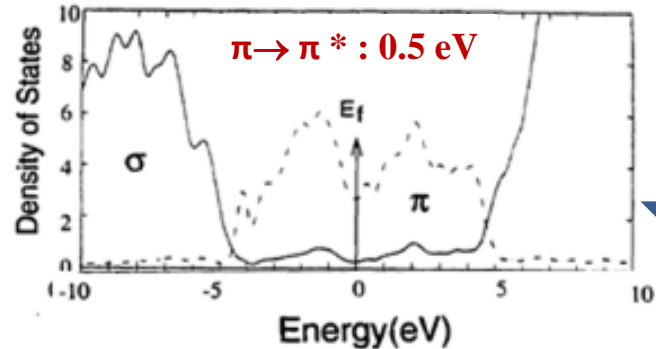
92 % sp^3 bonding



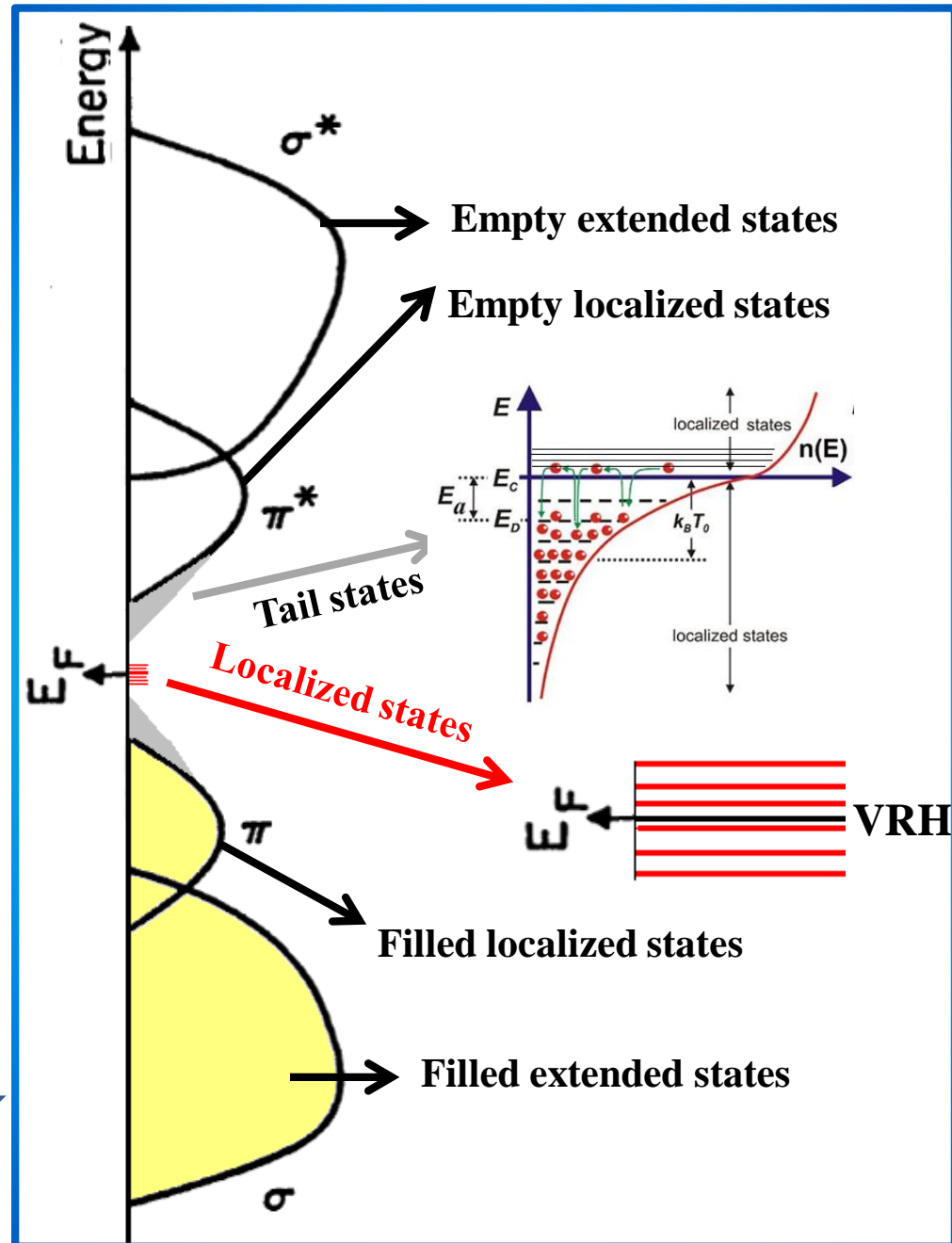
69 % sp^3 bonding



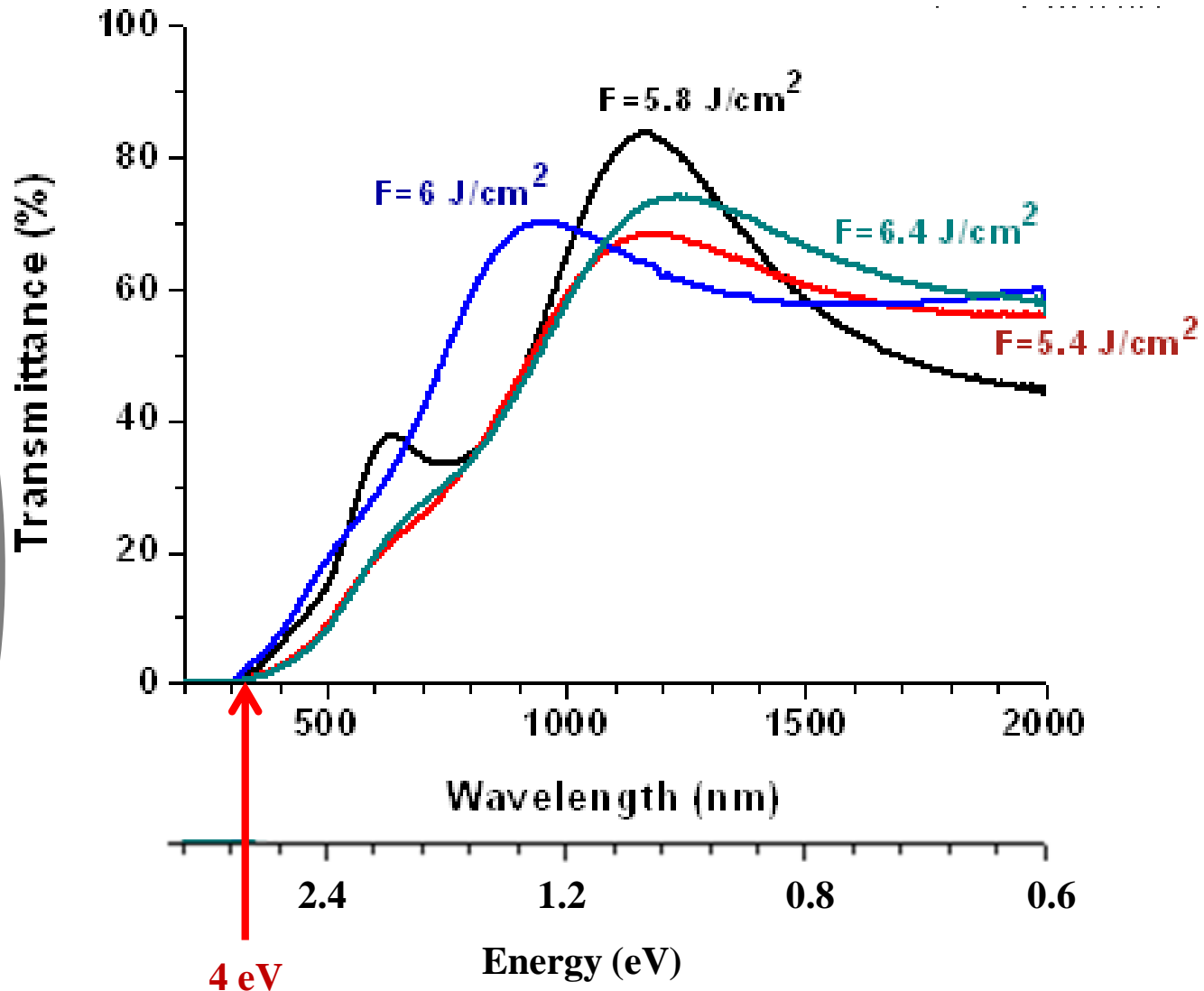
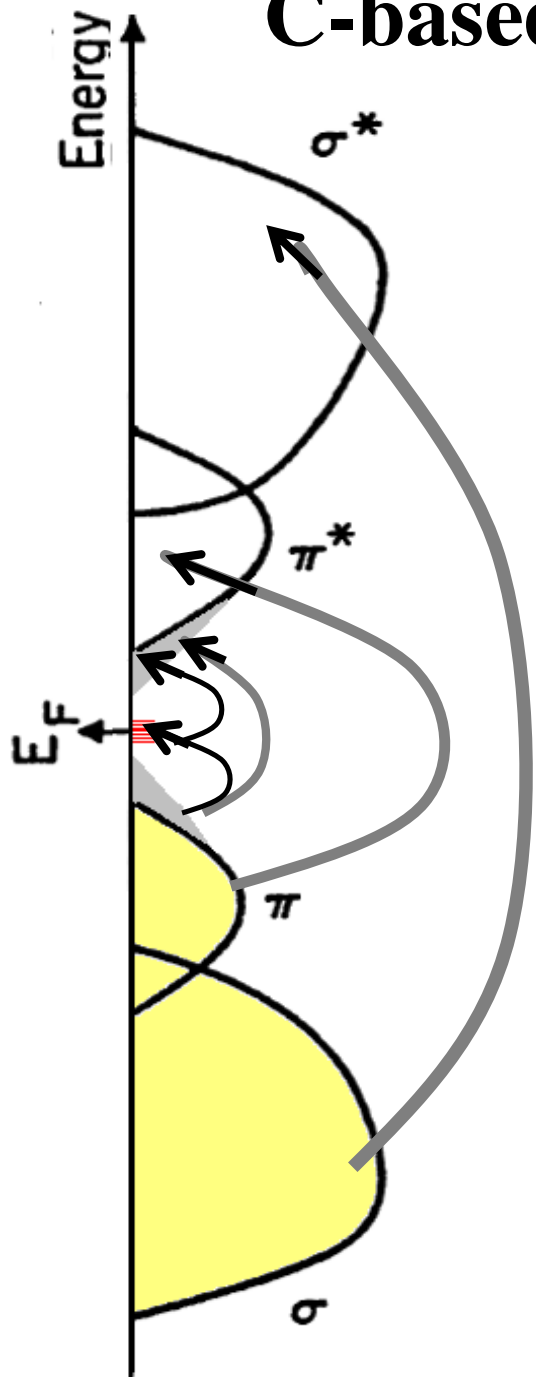
20 % sp^3 bonding



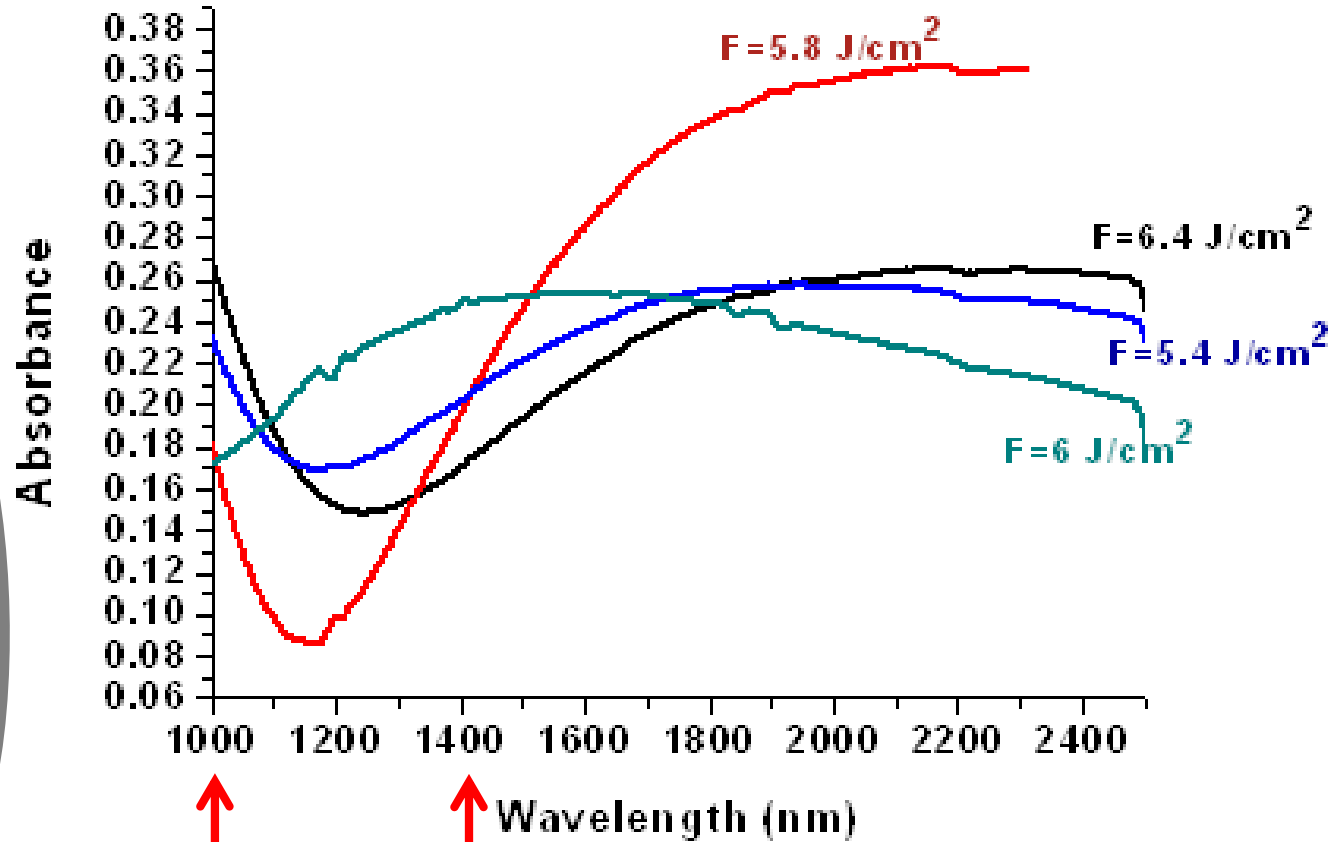
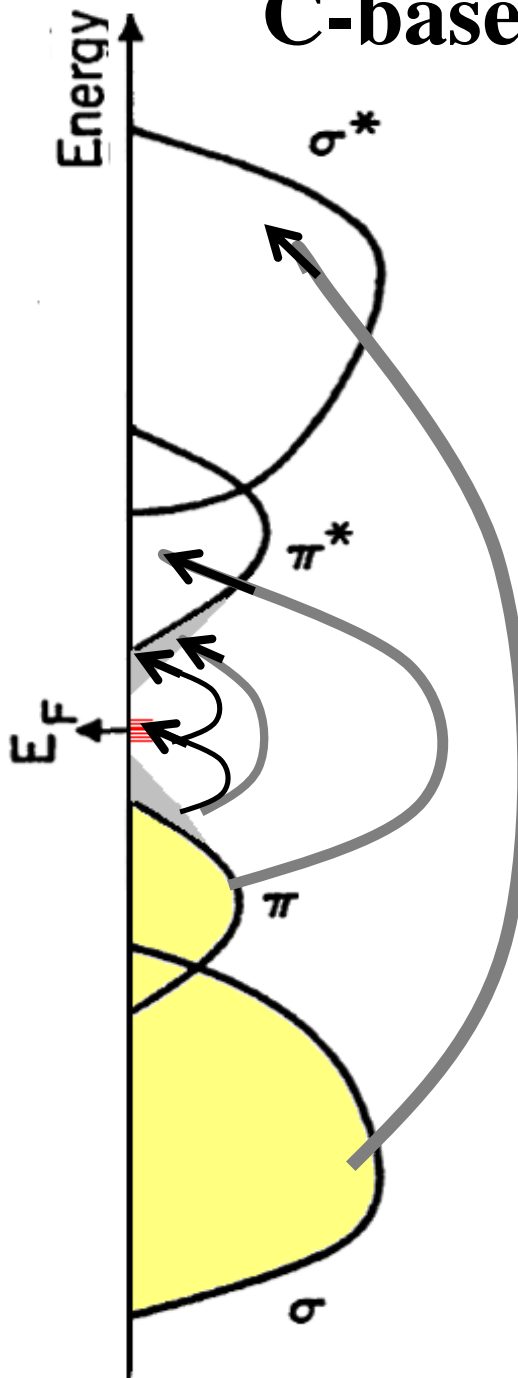
Increasing sp^2 bonding



C-based materials: electronic transitions



C-based materials: electronic transitions



1.24 eV

0.89 eV

Study in progress...



DLC by PLD: CONCLUSIONS

➔ **Optimal deposition conditions**

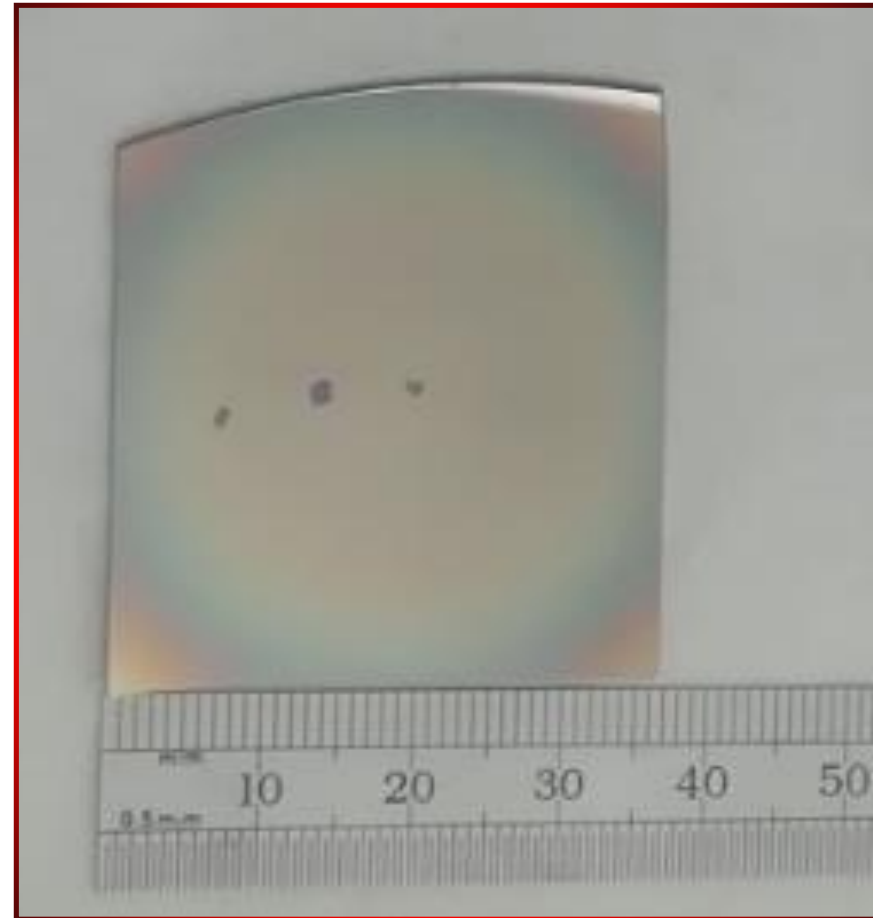
- **OFF-axis configuration**
- **Rotating substrate**
- **Small spot-area**



➔ **Good UNIFORMITY**
over a large area
of film and sp^3 bonds

➔ **Sheet resistance:**
 $10 \div 10^6 \text{ M}\Omega/\text{sqr}$

➔ **Physical insight**



Thank you very
much
for your
attention!